

**Performance**

- MultiBurst read: 15 MB/sec
- Sustained read: 9 MB/sec
- Sustained write: 2.4 MB/sec
- Access time:  
Normal: 33 nsec

**Protection & Security-Enabling Features**

- 16-byte Unique Identification (UID) number
- 16KByte user-controlled One Time Programmable (OTP) area
- Two configurable hardware-protected partitions for data and code:
  - Read-only mode
  - Write-only mode
  - One-Time Write mode (ROM-like) partition
  - Protection key and LOCK# signal
  - Sticky Lock (SLOCK) to lock boot partition
  - Protected Bad Block Table

**Reliability and Data Integrity**

- Hardware- and software-driven, on-the-fly EDC and ECC algorithms
- 4-bit Error Detection Code/Error Correction Code (EDC/ECC), based on a patented combination of BCH and Hamming code algorithms, tailored for MLC NAND flash technology
- Guaranteed data integrity after power failure
- Transparent bad-block management
- Dynamic and static wear-leveling

**Boot Capability**

- 2KB Programmable Boot Block with XIP capability to replace boot NOR
- Download Engine (DE) for automatic download of boot code from Programmable Boot Block
- Asynchronous Boot mode to boot from ARM-based CPUs, e.g. XScale, TI OMAP, Freescale MX without the need for external glue logic
- Virtual and Paged RAM boot modes. Enable booting from DiskOnChip under Secure Boot platforms
- Exceptional boot performance with MultiBurst operation and DMA support enhanced by external clock

**Hardware Compatibility**

- Configurable interface: simple NOR-like or multiplexed address/data interface
- CPU compatibility, including:
  - ARM-based CPUs
  - Texas Instruments OMAP, DBB
  - Intel XScale PXAxxx family
  - Infineon xGold family
  - Analog Devices (ADI) AD652x family
  - Freescale MX family
  - Zoran ER4525
  - Renesas SH mobile
  - Qualcomm MSMxxxx
  - AMD Alchemy
  - Motorola PowerPC™ MPC8xx
  - Hitachi SuperH™ SH-x
- Supports 8-, 16- and 32-bit architectures

**TrueFFS® Software**

- Full hard-disk read/write emulation for transparent file system management
- Patented TrueFFS
  - Flash file system management
  - Automatic block management
  - Data management to maximize the limit of typical flash life expectancy
  - Dynamic virtual mapping
- Dynamic and static wear-leveling
- Programming, duplicating, testing and debugging tools available in source code

**Operating Environment**

- Wide OS support, including:
  - Symbian OS
  - Microsoft Windows Mobile
  - Palm OS
  - Nucleus
  - Windows CE
  - Linux
  - OSE
  - VxWorks
- TrueFFS Software Development Kit (SDK) for quick and easy support for proprietary OSs, or OS-less environment
- TrueFFS Boot Software Development Kit (BDK)

**Power Requirements**

- Operating voltage
  - Core: 2.5V to 3.6V
  - I/O: 2.5V to 3.6V or 1.65 to 1.95V
- Current Consumption
  - Active mode:
    - Read 4.2mA
    - Program 7.4mA
    - Erase 7.4mA
  - Deep Power-Down mode:
    - 10  $\mu$ A (1Gb/128MB)
    - 20  $\mu$ A (2Gb/256MB)

**Capacity and Packaging**

- 128MB (1Gb) capacity (single die):
  - Device cascading option for up to four devices (4Gb)
  - 69-ball FBGA package:
    - 9x12x1.2 mm (width x length x height)
  - Ballout compatible with DiskOnChip G3/P3, G3/P3 LP and H1 FBGA products
- 256MB (2Gb) capacity (dual die):
  - Device cascading option for up to two devices (4Gb)
  - 69-ball FBGA package:
    - 9x12x1.4 mm (width x length x height)
  - Ballout compatible with DiskOnChip G3/P3, G3/P3 LP, H1 and, H3 FBGA products

## REVISION HISTORY

| Doc. No       | Revision | Date          | Description                                                                                  | Reference    |
|---------------|----------|---------------|----------------------------------------------------------------------------------------------|--------------|
| 92-DT-0305-00 | 0.1      | March 2005    | Preliminary version                                                                          | -            |
|               | 0.2      | October 2005  | Device ball number was reduced from 115 to 69 balls (only not connected balls were reduced). | Section 2    |
|               |          |               | Updated mechanical dimensions.                                                               | Section 10.4 |
|               |          |               | Updated Ordering Information.                                                                | Section 11   |
| 92-DS-1105-10 | 0.3      | November 2005 | Updated electrical information.                                                              | -            |

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## 1. INTRODUCTION

This data sheet includes the following sections:

- Section 1:** Overview of data sheet contents
- Section 2:** Product overview, including a brief product description, ball diagrams and signal descriptions
- Section 3:** Theory of operation for the major building blocks
- Section 4:** Major features and benefits of x2 technology
- Section 5:** Detailed description of hardware protection and security-enabling features
- Section 6:** Detailed description of modes of operation and TrueFFS technology, including power failure management and 8KByte memory window
- Section 7:** DiskOnChip G4 register descriptions
- Section 8:** Overview of how to boot from DiskOnChip G4
- Section 9:** Hardware and software design considerations
- Section 10:** Environmental, electrical, timing and product specifications
- Section 11:** Information on ordering DiskOnChip G4

For additional information on M-Systems' flash disk products, please contact one of the offices listed on the back page.



## 2. PRODUCT OVERVIEW

### 2.1 Product Description

DiskOnChip G4 is the latest addition to M-Systems' DiskOnChip product family. DiskOnChip G4, packed in a small FBGA package with 128MB (1Gb) capacity, is a single-die device with an embedded thin flash controller and flash memory. It uses Toshiba's cutting-edge, 90nm NAND-based Multi-Level Cell (MLC) large block flash technology, enhanced by M-Systems' proprietary x2 technology. A dual-die device is available with a single chip capacity of 256MB (2Gb).

MLC NAND technology enables two bits of data to be stored on a single cell, cutting in half the physical die size. M-Systems' proprietary x2 technology overcomes MLC-related error patterns and slow transfer rates by using a robust error detection and correction (EDC/ECC) mechanism. Furthermore, it provides performance enhancement with multi-plane operation, DMA support, turbo operation and MultiBurst operation. The combination of MLC and x2 technology results in a low-cost, minimal-sized flash disk that achieves unsurpassed reliability levels and enhanced performance.

This breakthrough in performance, size and cost makes DiskOnChip G4 the ideal solution for product manufacturers who require high-capacity, small size, high-performance, and above all, high-reliability storage to enable applications such as Digital TVs (DTVs), rugged handheld terminals, Digital Still Cameras (DSCs), Mobile Point of Sale (POS), telecom equipment, multimedia phones, camera and Video on Demand (VOD) phones, MP3 phones, enhanced Multimedia Messaging Service (MMS), gaming, video and Personal Information Management (PIM) on mobile handsets, and Personal Digital Assistants (PDAs).

As with the DiskOnChip G3, DiskOnChip G4 content protection and security-enabling features offer several benefits. Two write- and read-protected partitions, with both software- and hardware-based protection, can be configured independently for maximum design flexibility. The 16-byte Unique ID (UID) identifies each flash device, eliminating the need for a separate ID device on the motherboard. The 16KB One Time Programmable (OTP) area is written to once and then locked to prevent data and code from being altered, is ideal for storing customer and product-specific information.

DiskOnChip G4 has a 2KB Programmable Boot Block. This block provides eExecute In Place (XIP) functionality, enabling DiskOnChip G4 to replace the boot device and function as the only non-volatile memory device on-board. Eliminating the need for an additional boot device reduces hardware expenditures, board real estate, programming time, and logistics.

M-Systems' patented TrueFFS software technology fully emulates a hard disk to manage the files stored on DiskOnChip G4. This transparent file system management enables read/write operations that are identical to a standard, sector-based hard disk. In addition, TrueFFS employs patented methods, such as virtual mapping, dynamic and static wear-leveling, and automatic block management to ensure high data reliability and to maximize flash life expectancy.



## 2.2.2 System Interface

See Figure 2 for a simplified I/O diagram for a standard interface of DiskOnChip G4 128MB (1Gb) and 256MB (2Gb).

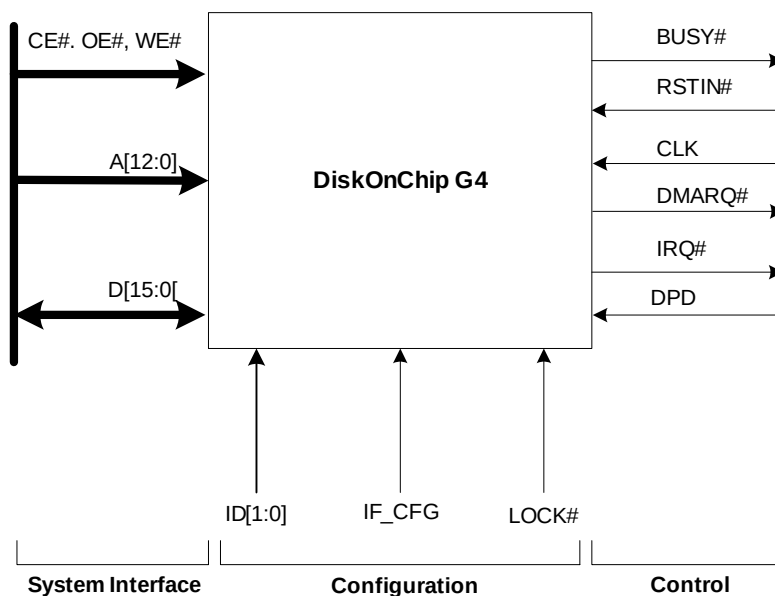


Figure 2: Standard Interface Simplified I/O Diagram

### 2.2.3 Signal Description

DiskOnChip G4 FBGA related ball designations are listed in the signal descriptions, presented in logic groups, in Table 1.

Table 1: Signal Descriptions for Standard Interface

| Signal                                  | Ball No.                                                 | Input Type <sup>1,2</sup> | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | Signal Type      |
|-----------------------------------------|----------------------------------------------------------|---------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|
| <b>System Interface</b>                 |                                                          |                           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                  |
| A[12:11]<br>A[10:8]<br>A[7:4]<br>A[3:0] | D8, C8<br>F7, E7, C7<br>C3, D3, E3, F3<br>D2, E2, F2, G2 | ST                        | Address bus. A0 is multiplexed with the DPD ball.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | Input            |
| D[15:14]<br>D[13:12]<br>D[11:8]         | H8, K8<br>H7, J7<br>K5, J4, H4, K3                       | ST, R8                    | Data bus, high byte. Not used and may be left floating when IF_CFG is set to 0 (8-bit mode).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Input/<br>Output |
| D[7:6]<br>D[5:3]<br>D[2:0]              | J8, G7<br>K7, H6, H5<br>K4, G4, J3                       | ST                        | Data bus, low byte.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | Input/<br>Output |
| CE#                                     | H2                                                       | ST                        | Chip Enable, active low.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | Input            |
| OE#                                     | H3                                                       | ST                        | Output Enable, active low.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | Input            |
| WE#                                     | C6                                                       | ST                        | Write Enable, active low.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | Input            |
| <b>Configuration</b>                    |                                                          |                           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                  |
| ID[1:0]                                 | G9, F8                                                   | ST                        | <p>Identification. Configuration control.</p> <p>DiskOnChip G4 128MB(1Gb) supports up to four chips cascaded in the same memory window:</p> <p>Chip 1 = ID1, ID0 = VSS, VSS (0,0); must be used for single chip configuration.</p> <p>Chip 2 = ID1, ID0 = VSS, VCCQ (0,1)</p> <p>Chip 3 = ID1, ID0 = VCCQ, VSS (1,0)</p> <p>Chip 4 = ID1, ID0 = VCCQ, VCCQ (1,1)</p> <p>DiskOnChip G4 256MB(2Gb) supports up to two chips cascaded in the same memory window:</p> <p>Chip 1 = ID1, ID0 = VSS, VSS (0,0); must be used for single chip configuration</p> <p>Chip 2 = ID1, ID0 = VCCQ, VCCQ (1,1)</p> | Input            |
| LOCK#                                   | E8                                                       | ST                        | Lock, active low. When active, provides full hardware data protection of selected partitions.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Input            |
| IF_CFG                                  | F4                                                       | ST                        | Interface Configuration, 1 (VCCQ) for 16-bit interface mode, 0 (VSS) for 8-bit interface mode.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | Input            |

| Signal         | Ball No.     | Input Type <sup>1,2</sup> | Description                                                                                                                                                                                                                                                   | Signal Type |
|----------------|--------------|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| <b>Control</b> |              |                           |                                                                                                                                                                                                                                                               |             |
| BUSY#          | E5           | OD                        | Busy, active low, open drain. Indicates that DiskOnChip is initializing and should not be accessed. A 10 K $\Omega$ pull-up resistor is required if this ball drives an input. A 10 K $\Omega$ pull-up resistor is recommended even if this ball is not used. | Output      |
| RSTIN#         | D5           | ST                        | Reset, active low.                                                                                                                                                                                                                                            | Input       |
| CLK            | K6           | ST                        | System Clock.                                                                                                                                                                                                                                                 | Input       |
| DMARQ#         | G8           | OD                        | DMA Request, active low. A 10 K $\Omega$ pull-up resistor is required if this ball drives an input. A 10 K $\Omega$ pull-up resistor is recommended even if this ball is not used.                                                                            | Output      |
| IRQ#           | F9           | OD                        | Interrupt Request, active low. A 10 K $\Omega$ pull-up resistor is required if this ball drives an input. A 10 K $\Omega$ pull-up resistor is recommended even if this ball is not used.                                                                      | Output      |
| DPD            | G2           | ST                        | Deep Power-Down. Used to enter and exit Deep Power-Down mode. This ball is assigned A0 instead of DPD when working in 8-bit mode.                                                                                                                             | Input       |
| <b>Power</b>   |              |                           |                                                                                                                                                                                                                                                               |             |
| VCC            | J5           | -                         | Device supply. Requires a 10 nF and 0.1 $\mu$ F capacitor.                                                                                                                                                                                                    | Supply      |
| VCCQ           | J6           | -                         | I/O power supply. Sets the logic <b>1</b> voltage level range of I/O balls. VCCQ may be either 2.5V to 3.6V or 1.65V to 1.95V. Requires a 10 nF and 0.1 $\mu$ F capacitor.                                                                                    | Supply      |
| VSS            | G3, J9       | -                         | Ground. All VSS balls must be connected.                                                                                                                                                                                                                      | Supply      |
| <b>Other</b>   |              |                           |                                                                                                                                                                                                                                                               |             |
| RSRVD          | See Figure 1 | -                         | Reserved. Other reserved signals are not connected internally and must be left floating to guarantee forward compatibility with future products.                                                                                                              |             |
|                | M            | -                         | Mechanical. These balls are for mechanical placement, and are not connected internally.                                                                                                                                                                       |             |

- The following abbreviations are used: IN - Standard (non-Schmidt) input, ST - Schmidt Trigger input, OD - Open drain output, R8 - Nominal 22K pull-up resistor, enabled only for 8-bit interface mode (IF\_CFG input is 0)
- Input buffers are Schmidt trigger type only for VCCQ>2.5V.

## 2.3 Multiplexed Interface

### 2.3.1 Ball Diagram

See Figure 3 for the DiskOnChip G4 ballout for the multiplexed interface. To ensure proper device functionality, balls marked RSRVD are reserved for future use and should not be connected.

Note: Forth-generation DiskOnChip G4 is designed as a drop-in replacement for all DiskOnChip products, assuming that the latter were integrated according to migration guide guidelines. Refer to the *DiskOnChip G3/P3 to G3/P3 LP, G4/P4, H1 to DiskOnChip H3* migration guide for further information.

### 9x12 FBGA Package

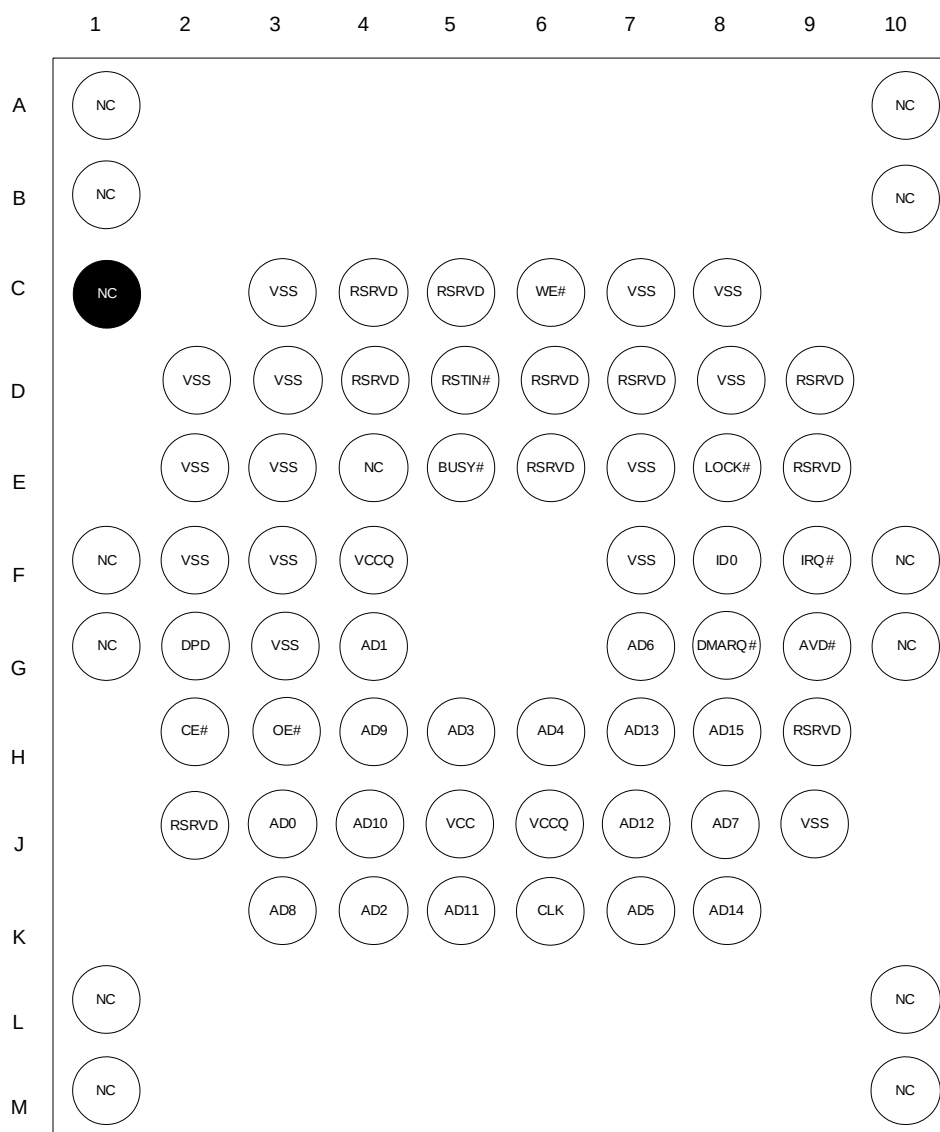


Figure 3 Ballout for Multiplexed Interface

### 2.3.2 System Interface

See Figure 4 for a simplified I/O diagram of DiskOnChip G4.

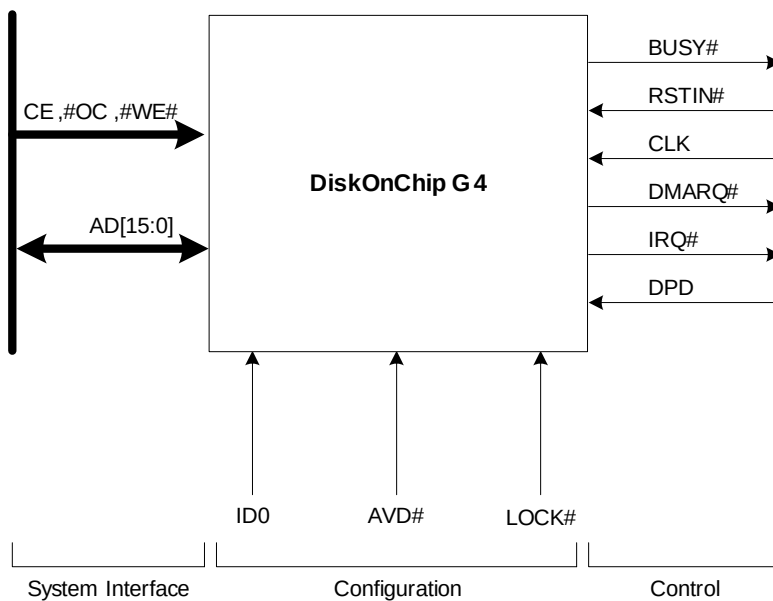


Figure 4: Multiplexed Interface Simplified I/O Diagram

### 2.3.3 Signal Description

DiskOnChip G4 FBGA related ball designations are listed in the signal descriptions, presented in logic groups, in Table 2.

Table 2: Signal Descriptions for Multiplexed Interface

| Signal                                                              | Pin No.                                                                  | Input Type <sup>1,2</sup> | Description                                                                                                                                                                                                                                                  | Signal Type      |
|---------------------------------------------------------------------|--------------------------------------------------------------------------|---------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|
| <b>System Interface</b>                                             |                                                                          |                           |                                                                                                                                                                                                                                                              |                  |
| AD[15:14]<br>AD[13:12]<br>AD[11:9]<br>AD[8:6]<br>AD[5:3]<br>AD[2:0] | H8, K8<br>H7, J7<br>K5, J4, H4<br>K3, J8, G7<br>K7, H6, H5<br>K4, G4, J3 | ST                        | Multiplexed bus. Address and data signals                                                                                                                                                                                                                    | Input/<br>Output |
| CE#                                                                 | H2                                                                       | ST                        | Chip Enable, active low                                                                                                                                                                                                                                      | Input            |
| OE#                                                                 | H3                                                                       | ST                        | Write Enable, active low                                                                                                                                                                                                                                     | Input            |
| WE#                                                                 | C6                                                                       | ST                        | Output Enable, active low                                                                                                                                                                                                                                    | Input            |
| <b>Configuration</b>                                                |                                                                          |                           |                                                                                                                                                                                                                                                              |                  |
| AVD#                                                                | G9                                                                       | ST                        | Address Valid. Set multiplexed interface                                                                                                                                                                                                                     | Input            |
| ID0                                                                 | F8                                                                       | ST                        | Identification. Configuration control to support up to two chips cascaded in the same memory window.<br>Chip 1 = ID0 = VSS; must be used for single-chip configuration<br>Chip 2 = ID0 = VCC                                                                 | Input            |
| LOCK#                                                               | E8                                                                       | ST                        | Lock, active low. When active, provides full hardware data protection of selected partitions.                                                                                                                                                                | Input            |
| <b>Control</b>                                                      |                                                                          |                           |                                                                                                                                                                                                                                                              |                  |
| BUSY#                                                               | E5                                                                       | OD                        | Busy, active low, open drain. Indicates that DiskOnChip is initializing and should not be accessed A 10 K $\Omega$ pull-up resistor is required if this ball drives an input. A 10 K $\Omega$ pull-up resistor is recommended even if this ball is not used. | Output           |
| RSTIN#                                                              | D5                                                                       | ST                        | Reset, active low.                                                                                                                                                                                                                                           | Input            |
| CLK                                                                 | K6                                                                       | ST                        | System Clock.                                                                                                                                                                                                                                                | Input            |
| DMARQ#                                                              | G8                                                                       | OD                        | DMA Request, active low. A 10 K $\Omega$ pull-up resistor is required if this ball drives an input. A 10 K $\Omega$ pull-up resistor is recommended even if this ball is not used.                                                                           | Output           |
| IRQ#                                                                | F9                                                                       | OD                        | Interrupt Request, active low. A 10 K $\Omega$ pull-up resistor is required if this ball drives an input. A 10 K $\Omega$ pull-up resistor is recommended even if this ball is not used.                                                                     | Output           |



| Signal       | Pin No.                                                | Input Type <sup>1,2</sup> | Description                                                                                                                                                         | Signal Type |
|--------------|--------------------------------------------------------|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| DPD          | G2                                                     | ST                        | Deep Power-Down. Used to enter and exit Deep Power-Down mode. Pin is assigned A0 instead of DPD when working in 8-bit mode.                                         | Input       |
| <b>Power</b> |                                                        |                           |                                                                                                                                                                     |             |
| VCC          | J5                                                     | -                         | Device core supply. Requires a 10 nF and 0.1 $\mu$ F capacitor.                                                                                                     | Supply      |
| VCCQ         | J6, F4                                                 | -                         | I/O power supply. Sets the logic 1 voltage level range of I/O balls. VCCQ may be either 2.5V to 3.6V or 1.65V to 1.95V. Requires a 10 nF and 0.1 $\mu$ F capacitor. | Supply      |
| VSS          | G3, J9, D8, C8, F7, E7, C7, C3, D3, E3, F3, D2, E2, F2 | -                         | Ground. All VSS pins must be connected.                                                                                                                             | Supply      |
| <b>Other</b> |                                                        |                           |                                                                                                                                                                     |             |
| RSRVD        | See Figure 3                                           | -                         | Reserved. Reserved signals are not connected internally and must be left floating to guarantee forward compatibility with future products.                          |             |
|              | M                                                      |                           | Mechanical. These balls are for mechanical placement, and are not connected internally.                                                                             |             |

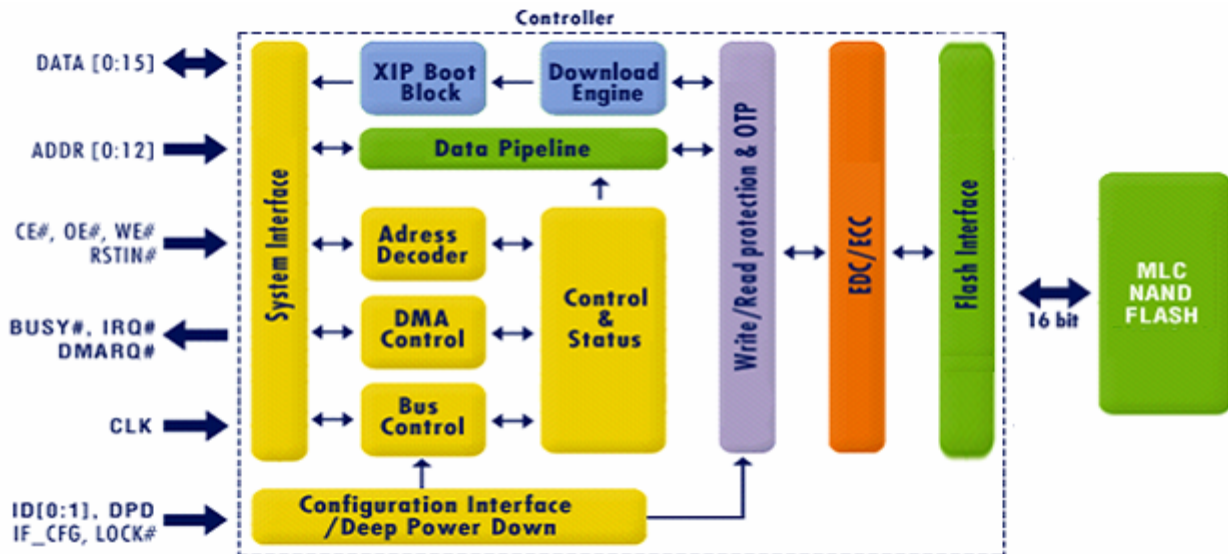
1. The following abbreviations are used: IN - Standard (non-Schmidt) input, ST - Schmidt Trigger input, OD - Open drain output  
Input buffers are Schmidt trigger type only for VCCQ>2.5V.

2. Input buffers are Schmidt trigger type only for VCCQ>2.5V.

### 3. THEORY OF OPERATION

#### 3.1 Overview

DiskOnChip G4 consists of the following major functional blocks, as shown in Figure 5.



\*ADDR[0] and DPD are multiplexed on the same ball/pin.

Figure 5: Simplified Block Diagram, Standard Interface

These components are described briefly below and in more detail in the following sections.

- **System Interface** for the host interface.
- **Configuration Interface** for configuring DiskOnChip G4 to operate in 8-bit, 16-bit mode, cascaded configuration, hardware read/write protection and entering/exiting Deep Power-Down mode.
- **Read/Write Protection and OTP** for advanced data/code security and protection.
- **Programmable Boot Block with XIP** functionality enhanced with a **Download Engine (DE)** for system initialization capability.
- **Error Detection and Error Correction Code (EDC/ECC)** for on-the-fly error handling.
- **Data Pipeline** through which the data flows from the system to the NAND flash arrays.
- **Control & Status** block that contains registers responsible for transferring the address, data and control information between the TrueFFS driver and the flash media.
- **Flash Interface** that interfaces to two NAND flash planes.
- **Bus Control** for translating the host bus address, and data and control signals into valid NAND flash signals.
- **Address Decoder** to enable the relevant unit inside the DiskOnChip controller, according to the address range received from the system interface.

## 3.2 System Interface

### 3.2.1 Standard (NOR-Like) Interface

The system interface block provides an easy-to-integrate NOR-like (also SRAM and EEPROM-like) interface to DiskOnChip G4 enabling it to interface with various CPU interfaces, such as a local bus, ISA bus, NOR interface, SRAM interface, EEPROM interface or any other compatible interface. In addition, the EEPROM-like interface enables direct access to the Programmable Boot Block to permit XIP (Execute-In-Place) functionality during system initialization.

A 13-bit wide address bus enables access to the DiskOnChip G4 8KB memory window (as shown in Section 6.5).

The Chip Enable (CE#), Write Enable (WE#) and Output Enable (OE#) signals trigger read and write cycles. A write cycle occurs while both the CE# and the WE# inputs are asserted. Similarly, a read cycle occurs while both the CE# and OE# inputs are asserted. Note that DiskOnChip G4 does not require a clock signal. It features a unique analog static design, optimized for minimal power consumption. The CE#, WE# and OE# signals trigger the controller (e.g., system interface block, bus control and data pipeline) and flash access.

The Reset In (RSTIN#) and Busy (BUSY#) control signals are used in the reset phase.

The Interrupt Request (IRQ#) signal can be used when long I/O operations, such as Block Erase, delay the CPU resources. The signal is also asserted when a Data Protection violation has occurred. This signal frees the CPU to run other tasks, continuing read/write operations with DiskOnChip G4 only after the IRQ# signal has been asserted and an interrupt handling routine (implemented in the OS) has been called to return control to the TrueFFS driver.

The DMARQ# output is used to control multi-page DMA operations, and the CLK input is used to support MultiBurst operation when reading flash data. See Section 4.1 for further information.

### 3.2.2 Multiplexed Interface

In this configuration, the address and data signals are multiplexed. The ID[1] input is driven by the host AVD# signal, and the D[15:0] pins/balls, used for both address inputs and data, are connected to the host AD[15:0] bus. While AVD# is asserted, the host drives AD[11:0] with bits [12:1] of the address. Host signals AD[15:12] are not significant during this part of the cycle.

This interface is automatically used when a falling edge is detected on ID[1]. This edge must occur after RSTIN# is negated and before the first read or write cycle to the controller. When using a multiplexed interface, the value of ID[1] is internally forced to logic-0. The only possible device ID values are 0 and 1; therefore, only up to two DiskOnChip G4 128MB (1Gb) devices may be cascaded in multiplexed configuration (dual-die DiskOnChip G4 256MB (2Gb) cannot be cascaded when used in a multiplexed interface).

## 3.3 Configuration Interface

The Configuration Interface block enables the designer to configure DiskOnChip G4 to operate in different modes. The ID[1:0] signals are used in a cascaded configuration (refer to Section 9.6), the DPD signal is used to enter and exit Deep Power-Down mode (see Section 6.3), the LOCK# signal

is used for hardware write/read protection, and the IF\_CFG signal is used to configure 8/16-bit access.

### 3.4 Protection and Security-Enabling Features

The Protection and Security-Enabling block, consisting of read/write protection, UID and an OTP area, enables advanced data and code security and content protection. Located on the main route of traffic between the host and the flash, this block monitors and controls all data and code transactions to and from DiskOnChip G4.

#### 3.4.1 Read/Write Protection

Data and code protection is implemented through a Protection State Machine (PSM). The user can configure one or two independently programmable areas of the flash memory as read protected, write protected, or read/write protected.

A protected partition may be protected by either/both of these hardware mechanisms:

- 64-bit protection key
- Hard-wired LOCK# signal

If the Lock option is enabled (by means of software) and the LOCK# signal is asserted, the protected partition has an additional hardware lock that prevents read/write access to the partition, even with the use of the correct protection key.

The size and protection attributes of the protected partition are defined during the media-formatting stage.

In the event of an attempt to bypass the protection mechanism, illegally modify the protection key or in any way sabotage the configuration parameters, the entire DiskOnChip G4 becomes both read and write protected, and is completely inaccessible.

For further information on hardware protection, please refer to the *TrueFFS Software Development Kit (SDK)* developer guide.

#### 3.4.2 Unique Identification (UID) Number

Each DiskOnChip G4 is assigned a 16-byte UID number. Burned onto the flash during production, the UID cannot be altered and is unique worldwide. The UID is essential in security-related applications, and can be used to identify end-user products in order to fight fraudulent duplication by imitators.

#### 3.4.3 One-Time Programmable (OTP) Area

The 16KB OTP area is user programmable for complete customization. The user can write to this area once, after which it is automatically and permanently locked. After it is locked, the OTP area becomes read only, just like a ROM device.

Regardless of the state of any of the LOCK bytes, the OTP pages cannot be erased.

Typically, the OTP area is used to store customer and product information such as: product ID, software version, production data, customer ID, Service provider information and tracking information.

#### 3.4.4 One-Time Write (ROM-Like) Partition

A partition in the DiskOnChip G4 can be set as One-Time Write. After it is locked, this partition becomes read only, just like a ROM device. Its capacity is defined during the media-formatting stage.

#### 3.4.5 Sticky Lock (SLOCK)

The boot partition can be locked automatically by hardware after the boot phase is completed and the device is in Normal mode. This is done by setting the Sticky Lock (SLOCK) bit in the Output Control register to 1. This has the same effect as asserting the LOCK# signal. Once set, SLOCK can only be cleared by asserting the RSTIN# input. Like the LOCK# input, assertion of this bit prevents the protection key from disabling the protection for a given partition. There is no need to mount the partition before calling a hardware protection routine.

This feature can be useful when the boot code in the boot partition must be read/write protected. Upon power-up, the boot code must be unprotected so the CPU can boot directly from DiskOnChip. At the end of the boot process, protection can be set until the next power-up or reset.

### 3.5 Programmable Boot Block with eXecute In Place (XIP) Functionality

The Programmable Boot Block with XIP functionality enables DiskOnChip G4 to act as a boot device in addition to performing flash disk data storage functions. This eliminates the need for expensive, legacy NOR flash or any other boot device on the motherboard.

The Programmable Boot Block on DiskOnChip G4 is 2KB in size. The Download Engine (DE), described in the next section, expands the functionality of this block by copying the boot code from the flash into the boot block.

DiskOnChip G4 128MB (1Gb) devices may be cascaded in order to form a larger flash disk. When DiskOnChip G4 128MB (1Gb) is connected with a standard NOR-like interface, up to four devices may be cascaded to create a 4Gb flash disk. When DiskOnChip G4 128MB (1Gb) is connected with a multiplexed interface, up to two devices may be cascaded to create a 256MB (2Gb) flash disk.

- Notes:
1. When more than one DiskOnChip G4 128MB (1Gb) device is cascaded, a maximum boot block of 2KB is available.
  2. The Programmable Boot Block size available for DiskOnChip G4 256MB (2Gb) is 2 KB as well.

### 3.6 Download Engine (DE)

Upon power-up or when the RSTIN# signal is asserted, the DE automatically downloads the Initial Program Loader (IPL) to the Programmable Boot Block. The IPL is responsible for starting the booting process. The download process is quick, and is designed so that when the CPU accesses DiskOnChip G4 for code execution, the IPL code is already located in the Programmable Boot Block. During the download process, DiskOnChip G4 does not respond to read or write accesses. Host systems must therefore observe the requirements described in Section 10.3.8.

In addition, the DE downloads the data protection rules from the flash to the Protection State Machines (PSM), so that DiskOnChip G4 is secure and protected from the first moment it is active.

During the download process, DiskOnChip G4 asserts the BUSY# signal to indicate to the system that it is not yet ready to be accessed. Once BUSY# is negated, the system can access DiskOnChip G4.

A failsafe mechanism prevents improper initialization due to a faulty VCC or invalid assertion of the RSTIN# input. Another failsafe mechanism is designed to overcome possible NAND flash data errors. It prevents internal registers from powering up in a state that bypasses the intended data protection. In addition, any attempt to sabotage the data structures causes the entire DiskOnChip to become both read and write protected, and completely inaccessible.

### 3.7 Error Detection Code/Error Correction Code (EDC/ECC)

Because NAND-based MLC flash is prone to errors, it requires unique error-handling capability. M-Systems' x2 technology implements 4-bit Error Detection Code/Error Correction Code (EDC/ECC), based on a patented combination of Bose, Chaudhuri and Hocquenghem (BCH) and Hamming code algorithms. Error Detection Code (EDC) is implemented in hardware to optimize performance, while Error Correction Code (ECC) is performed in software, when required, to save silicon costs.

Each time a 512-byte page is written, additional parity bits are calculated and written to the flash. Each time data is read from the flash, the parity bits are read and used to calculate error locations.

The Hamming code can detect 2 errors per page and correct 1 error per page. The BCH code can detect and correct 4 errors per page. It can even detect 5 errors per page with a probability of 99.9%. It ensures that the minimal amount of code required is used for detection and correction to deliver the required reliability without degrading performance.

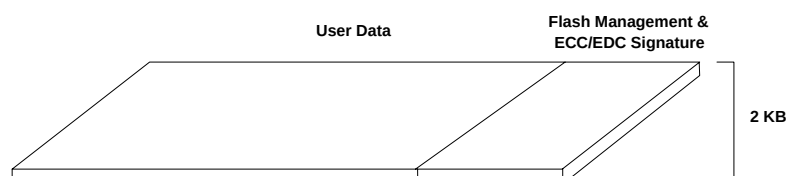
### 3.8 Control and Status

The Control and Status block contains registers responsible for transferring address, data and control information between the DiskOnChip TrueFFS driver and the flash media. Additional registers are used to monitor the status of the flash media (ready/busy) and the DiskOnChip controller. For further information on the DiskOnChip registers, refer to Section 7.

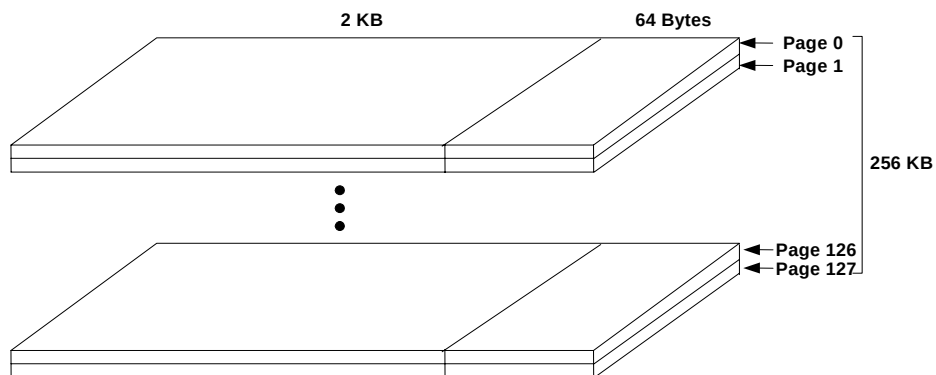
### 3.9 Flash Architecture

DiskOnChip G4 128MB (1Gb) consists of one 128MB (1Gb) flash planes that consist of 512 blocks, organized in 128 pages, as follows:

- **Page** – Each page contains 2048 bytes of user data and a 64-byte extra area that is used to store flash management and EDC/ECC signature data, as shown in Figure 6.
- **Block (Erase Unit)** – Each block contains 128 pages (total of 256KB), as shown in Figure 7. A block is the minimal unit that can be erased, and is sometimes referred to as an erase block.



*Figure 6: Page Structure*



*Figure 7: Block Structure*



## 4. x2 TECHNOLOGY

DiskOnChip G4 enhances performance using various proprietary techniques:

- MultiBurst operation to read large chunks of data, providing a MultiBurst read speed of up to 15 MB/sec.
- DMA operation to release the CPU for other tasks in coordination with the platform's DMA controller. This is especially useful during the boot stage. Up to 256KB of data can be transferred during a DMA operation.

### 4.1 MultiBurst Operation

MultiBurst operation is especially effective for large file reads that are typical during boot-up. During MultiBurst operation, data is read from the flash through a 16-bit wide internal flash interface. Data is read by the host one 16-bit word after another using the CLK input, resulting in a MultiBurst read mode of up to 15 MB/sec. MultiBurst operation can only be performed on hosts that support burst reads. See Figure 8 below.

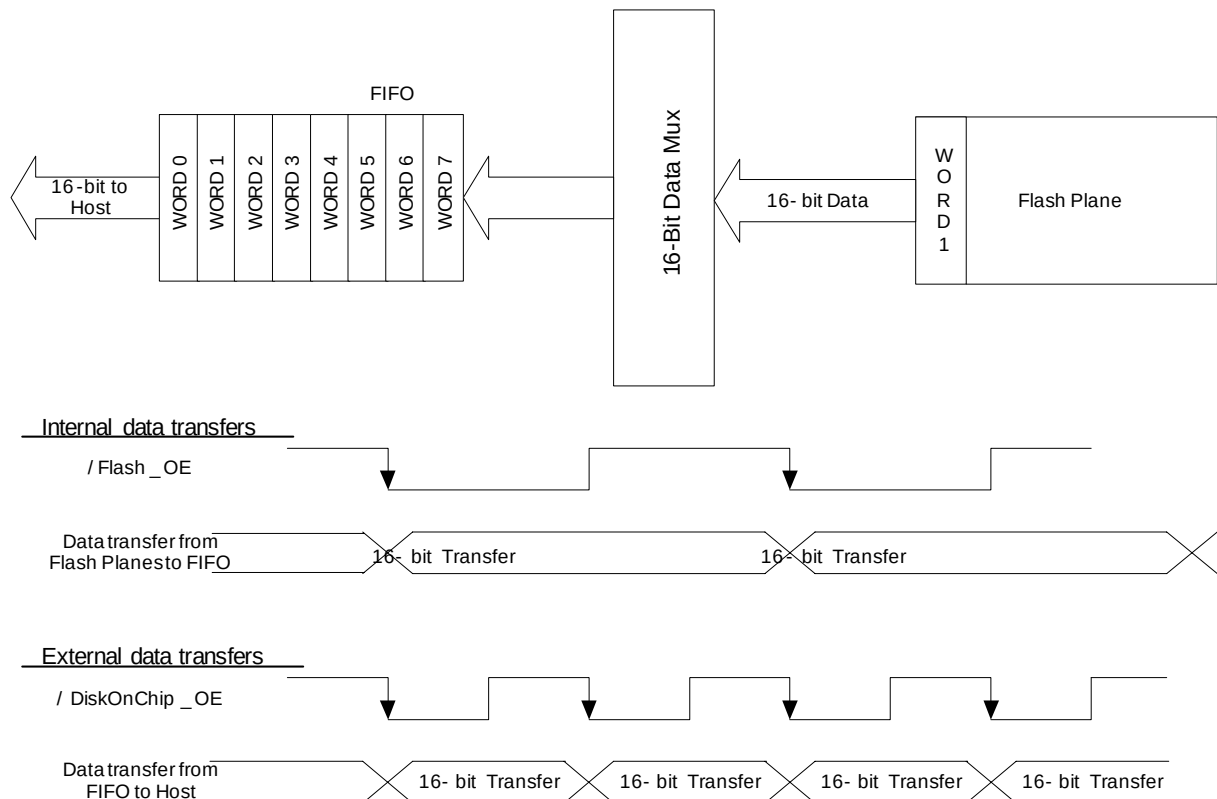


Figure 8: MultiBurst Operation

Note: DiskOnChip G4 does not support MultiBurst write operations.



MultiBurst operation is controlled by 5 bits in the MultiBurst Mode Control register: BURST\_EN, CLK\_INV, LATENCY, HOLD and LENGTH. For full details on this register, please refer to Section 7.

MultiBurst mode read cycles are supported via the CLK input, which is enabled by setting the BURST\_EN bit in the MultiBurst Mode Control register.

To determine whether the rising or falling edge of the CLK input is sampled (called CLK0), the CLK\_INV bit in the MultiBurst Mode Control register must be specified. When the CLK\_INV bit is set to 0, CE# and OE# are sampled on the rising edge of CLK; when the CLK\_INV bit is set to 1, sampling is done on the falling edge of CLK.

- Notes:
1. When the CLK\_INV bit is set to 1, sampling is done on the falling edge of CLK, and an additional half-clock cycle of latency is incurred. Data continues to be output on D[15:0] on the rising edge of CLK.
  2. Burst mode is disabled upon assertion of the RSTIN# input, and the signal may therefore be left floating.

The LATENCY field is the third field that must be set in the MultiBurst Mode Control register. When the LATENCY field is set to 0, the host can latch the first 16-bit data word two clock cycles after CLK0. This time can be extended by up to seven clock cycles by programming the LATENCY field. After latching the first word, additional 16-bit data words can be latched on each subsequent clock cycle.

The HOLD bit in the MultiBurst Mode Control register can be set to hold each data word valid for two clock cycles rather than one.

The LENGTH field in the MultiBurst Mode Control register must be programmed with the length of the burst to be performed. As read cycles from the flash are volatile, each burst cycle must read exactly this number of words.

The CLK input can be toggled continuously or can be halted. When halting the CLK input, the following guidelines must be observed:

- After asserting OE# and CE#, LATENCY + 2 CLK cycles are required prior to latching the first word (2.5 CLK cycles if CLK\_INV is set to 1).
- If the HOLD bit is set to 0, the host must provide one rising CLK edge for each word read, except for the last word latched, for which CLK does not need to be toggled.
- If the HOLD bit is set to 1, the host must provide two rising CLK edges for each word read, except for the last word, for which the second of the two CLK rising edges is not required.
- Subsequent toggling of the CLK is optional.

Two modes are provided to improve compatibility with hosts which can provide only a high CLK frequency. In each of these modes, a clock divider is used to generate only one DiskOnChip clock cycle for every two cycles of the CLK input.

- Hold mode: Causes each data word to be held for two clock cycles instead of one. Best used on platforms which support Hold mode and offer large burst lengths.

- FIFO mode: Enables FIFO in the data path. The FIFO outputs data on each cycle of the CLK input, while the FIFO is filled with Flash data on every other cycle.
  - 16-bit hosts: Burst length is limited to 16 bytes. One cycle of latency is required for each word in the burst length. Best used on platforms which do not support Hold mode or which offer only shorter burst lengths.
  - 8-bit host: No special limits on burst length, and only one additional cycle of latency is required.

Note: Hold and FIFO modes are enabled by the HOLD and FIFO bits bit of Burst Mode control Register respectively. Usage of these modes is mutually exclusive.

## 4.2 DMA Operation

DiskOnChip G4 provides a DMARQ# output that enables up to 256KB to be read from the flash by the host DMA controller. During DMA operation, the DMARQ# output is used to notify the host DMA controller that the next flash page is ready to be read, and the IRQ# pin indicates whether an error occurred while reading the data from the flash or the end of the DMA transfer was reached.

The DMARQ# output sensitivity is chosen by setting the EDGE bit in the DMA Control register[0]:

- **Edge** – The DMARQ# output pulses to logic 0 for 250~500 nsec to indicate to the DMA controller that a flash page is ready to be read. The EDGE bit is set to 1 for this mode.
- **Level** – The DMARQ# output is asserted to initiate the block transfer and returns to the negated state at the end of each block transfer. The EDGE bit is set to 0 for this mode.

The following steps are required to initiate a DMA operation:

1. Initialize the platform's DMA controller to transfer 512 bytes upon each assertion of the DMARQ# output. If the DMA controller supports an edge-sensitive DMARQ# signal, then initialize the DMA controller to transfer 512 bytes upon each DMA request. If the DMA controller supports a level-sensitive DMARQ# signal, then initialize the DMA controller to transfer data while DMARQ# is asserted.
2. Set the bits in the Interrupt Control register (see Section 7) to enable interrupts on an ECC error and at the end of the DMA operation.
3. Write to the DMA Control register[0] to set the DMA\_EN bit, the EDGE bit and the number of sectors (SECTOR\_COUNT field) to be transferred to the host. At this point, DiskOnChip G4 generates a DMA request to indicate to the host that it is ready to transfer data.
4. The host DMA controller reads one sector (512 bytes) of data from DiskOnChip G4.
5. If an ECC error is detected, an interrupt is generated (IRQ# signal asserted), the transfer of data is halted and control is returned to the host. If no ECC error is detected, a DMA request is initiated (DMARQ# signal asserted) and the next sector is read by the host.
6. The process continues until the last sector is read, after which DiskOnChip G4 generates an interrupt (IRQ# signal asserted) to indicate that it has transferred the last byte.

Notes: 1. DiskOnChip G4 generates a DMA request (DMARQ# signal asserted) after the last byte is read. It may therefore be necessary to clear the final DMA request from the DMA controller.

2. DMA operation may be aborted after transferring each 512-byte block (step 4) by clearing the DMA\_EN bit in the DMA Control register[0].

### 4.3 Combined MultiBurst Mode and DMA Operation

When using MultiBurst mode and DMA operation together, and an interrupt is generated (IRQ# signal asserted), the Download Status register cannot be polled, as it will not comply with the MultiBurst mode timing specification. The following sequence is therefore required to respond to an interrupt request while in MultiBurst mode:

- Perform 7 write cycles to the NOP register.
- Turn off MultiBurst mode by writing to the MultiBurst Mode Control register.

## 5. HARDWARE PROTECTION

### 5.1 Method of Operation

DiskOnChip G4 enables the user to define two partitions that are protected (in hardware) against any combination of read or write operations. The two protected areas can be configured as read protected or write protected, and are protected by a protection key (i.e. password) defined by the user. Each of the protected areas can be configured separately and can function separately, providing maximum flexibility for the user.

The size and protection attributes (protection key, read, write, changeable, lock) of the protected partition are defined in the media formatting stage (DFORMAT utility or the format function in the TrueFFS SDK).

In order to set or remove read/write protection, the protection key (i.e., password) must be used, as follows:

- Insert the protection key to remove read/write protection.
- Remove the protection key to set read/write protection.

DiskOnChip G4 has an additional hardware safety measure. If the Lock option is enabled (by means of software) and the LOCK# signal is asserted, the protected partition has an additional hardware lock that prevents read/write access to the partition, even with the use of the correct protection key. It is possible to set the Lock protection for one session only; that is, until the next power-up or reset. This Sticky Lock feature can be useful when the boot code in the boot partition must be read/write protected. Upon power-up, the boot code must be unprotected so the CPU can run it directly from DiskOnChip G4. At the end of the boot process, protection can be set until the next power-up or reset.

Setting the Sticky Lock (SLOCK) bit in the Output Control register to 1 has the same effect as asserting the LOCK# signal. Once set, SLOCK can only be cleared by asserting the RSTIN# input. Like the LOCK# input, the assertion of this bit prevents the protection key from disabling the protection for a given partition. For more information, see Section 3.4.5. The target partition does require mounting before calling a hardware protection routine.

The only way to read or write from a protected partition is to insert the key (even DFORMAT cannot remove the protection). This is also true for modifying its attributes (protection key, read, write and lock). Read/write protection is disabled (the key is automatically removed) in each of the following events:

- Power-down
- Change of any protection attribute (not necessarily in the same partition)
- Write operation to the IPL area
- Removal of the protection key.

For further information on hardware protection, please refer to the *TrueFFS Software Development Kit (SDK)* developer guide.

## 6. MODES OF OPERATION

DiskOnChip G4 operates in one of three basic modes:

- Normal mode
- Reset mode
- Deep Power-Down mode

The current mode of the chip can always be determined by reading the DiskOnChip Control register. Mode changes can occur due to any of the following events:

- Assertion of the RSTIN# signal sets the device in Reset mode.
- During host power-up, boot detector circuitry sets the device in Reset mode.
- A valid write sequence to DiskOnChip G4 sets the device in Normal mode. This is done automatically by the TrueFFS driver on power-up (reset sequence end).
- Switching back from Normal mode to Reset mode can be done by a valid write sequence to DiskOnChip G4, or by triggering the boot detector circuitry (via a soft reset).
- Deep Power-Down
  - A valid write sequence, initiated by software, sets the device from Normal mode to Deep Power-Down mode. Twelve read cycles from offset 0x1FFF set the device back to Normal mode. Alternately, the device can be set back to Normal mode with an extended access time during a read from the Programmable Boot Block.
  - Asserting the RSTIN# signal and holding it in this state puts the device in Deep Power-Down mode. When RSTIN# is released, the device is left in Reset mode.
  - Toggling the DPD signal as defined by the DPD Control register.

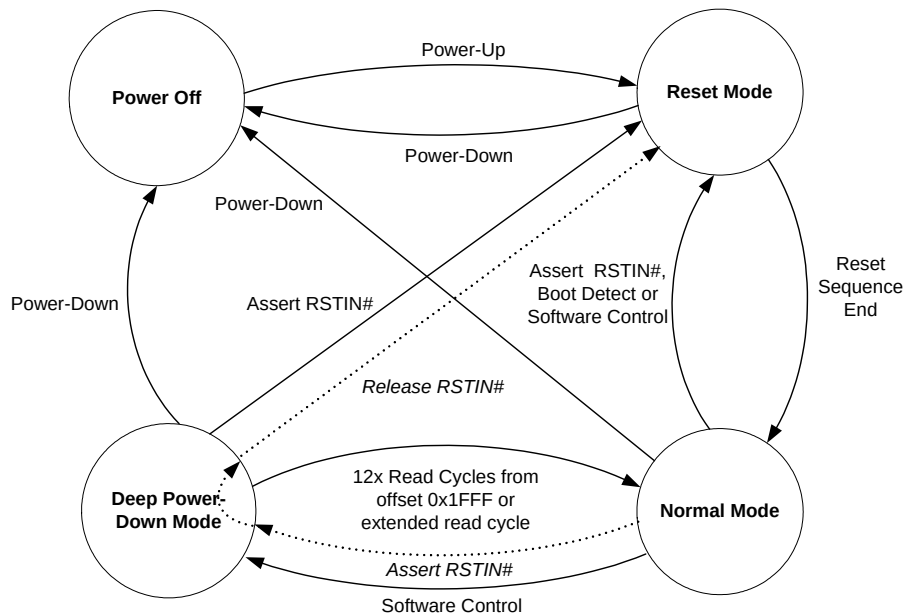


Figure 9: Operation Modes and Related Events

## 6.1 Normal Mode

This is the mode in which standard operations involving the flash memory are performed. Normal mode is entered when a valid write sequence is sent to the DiskOnChip Control register and Control Confirmation register. A write cycle occurs when both the CE# and WE# inputs are asserted. Similarly, a read cycle occurs when both the CE# and OE# inputs are asserted. Because the flash controller generates its internal clock from these CPU bus signals and some read operations return volatile data, it is essential that the timing requirements specified in Section 10.3 be met. It is also essential that read and write cycles not be interrupted by glitches or ringing on the CE#, WE#, and OE# inputs. All inputs to DiskOnChip G4 are Schmidt Trigger types to improve noise immunity.

## 6.2 Reset Mode

In Reset mode, DiskOnChip G4 ignores all write cycles, except for those to the DiskOnChip Control register and Control Confirmation register. All register read cycles return a value of 00H.

Before attempting to perform any operation, the device is set to Normal mode by TrueFFS software.

## 6.3 Deep Power-Down Mode

While in Deep Power-Down mode, DiskOnChip G4's quiescent power dissipation is reduced by disabling internal high current consumers (e.g. voltage regulators, input buffers, oscillator etc.). The following signals are also disabled in this mode:

- **Standard interface:** Input buffers A[12:0], WE#, D[15:0] and OE# (when CE# is negated)
- **Multiplexed interface:** Input buffers AD[15:0], AVD#, WE# and OE# (when CE# is negated).

To enter Deep Power-Down mode, a proper sequence must be written to the DiskOnChip G4 Control registers and the CE# input must be negated. All other inputs should be VSS or VCC.

Asserting the RSTIN# signal and holding it in low state puts the device in Deep Power-Down mode. When the RSTIN# signal is released, the device is left in Reset mode.

Toggling the DPD signal, as defined by the DPD Control register, puts the device in Power-Down mode as well.

In Deep Power-Down mode, write cycles have no effect and read cycles return indeterminate data (DiskOnChip G4 does not drive the data bus). Entering Deep Power-Down mode and then returning to the previous mode does not affect the value of any register.

To exit Deep Power-Down mode, use one of the following methods:

- Read twelve times from address 1FFFH (Programmable Boot Block). The data returned is undefined.
- Perform a single read cycle from the Programmable Boot Block with an extended access time and address hold time as specified in the timing diagrams. The data returned will be correct. Please note that this option can only be used with a standard interface, not with a multiplexed interface.

- Toggle the DPD input as defined by the DPD Control register, wait a minimum of 700 nS, and then perform a read/write cycle with normal timing, as specified in the timing diagrams.

Applications that use DiskOnChip G4 as a boot device must ensure that the device is not in Deep Power-Down mode before reading the Boot vector/instructions. This can be done by pulsing RSTIN# to the asserted state and waiting for the BUSY# output to be negated, toggling the DPD signal, or by entering Reset mode via software.

## 6.4 TrueFFS Technology

### 6.4.1 General Description

M-Systems' patented TrueFFS technology was designed to maximize the benefits of flash memory while overcoming inherent flash limitations that would otherwise reduce its performance, reliability and lifetime. TrueFFS emulates a hard disk, making it completely transparent to the OS. In addition, since it operates under the OS file system layer (see Figure 10), it is completely transparent to the application.

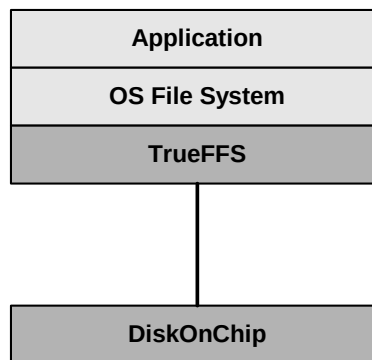


Figure 10: TrueFFS Location in System Hierarchy

TrueFFS technology support includes:

- Binary driver support for all major OSs
- TrueFFS Software Development Kit (TrueFFS SDK)
- Boot Software Development Kit (BDK)
- Support for all major CPUs, including 8, 16 and 32-bit bus architectures.

TrueFFS technology features:

- Block device API
- Flash file system management
- Bad-block management
- Dynamic virtual mapping
- Dynamic and static wear-leveling



- Power failure management
- Implementation of MLC-tailored EDC/ECC
- Performance optimization
- Compatibility with all DiskOnChip products

#### 6.4.2 Built-In Operating System Support

The TrueFFS driver is integrated into all major OSs, including Symbian, Palm OS, Microsoft Windows Mobile, Windows CE, Linux (various kernels), Nucleus, OSE and others. For a complete listing of all available drivers, please refer to M-Systems' website, [www.m-systems.com](http://www.m-systems.com). It is advised to use the latest driver versions that can be downloaded from the website.

#### 6.4.3 TrueFFS Software Development Kit (SDK)

The basic *TrueFFS Software Development Kit (SDK)* developer guide provides the source code for the TrueFFS driver. It can be used in an OS-less environment or when special customization of the driver is required for proprietary OSs.

When using DiskOnChip G4 as the boot replacement device, TrueFFS SDK also incorporates in its source code the boot software that is required for this configuration (this package is also available separately). Please refer to the *DiskOnChip Boot Software Development Kit (BDK)* developer guide for further information on using this software package.

Note: DiskOnChip G4 is supported by TrueFFS 6.3 and above.

#### 6.4.4 File Management

TrueFFS accesses the flash memory within DiskOnChip G4 through an 8KB window in the CPU memory space. TrueFFS provides block device API by using standard file system calls, identical to those used by a mechanical hard disk, to enable reading from and writing to any sector on DiskOnChip G4. This makes DiskOnChip G4 compatible with any file system and file system utilities, such as diagnostic tools and applications.

Note: DiskOnChip G4 is shipped unformatted and contains virgin media.

#### 6.4.5 Bad-Block Management

Since NAND flash is an imperfect storage media, it can contain bad blocks that cannot be used for storage because of their high error rates. TrueFFS automatically detects and maps out bad blocks upon system initialization, ensuring that they are not used for storage. This management process is completely transparent to the user, who is unaware of the existence and location of bad blocks, while remaining confident of the integrity of data stored.

#### 6.4.6 Wear-Leveling

Flash memory can be erased a limited number of times. This number is called the *erase cycle limit*, or *write endurance limit*, and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device.

In a typical application, and especially if a file system is used, specific pages are constantly updated (e.g., the page/s that contain the FAT, registry, etc.). Without any special handling, these pages would wear out more rapidly than other pages, reducing the lifetime of the entire flash.

To overcome this inherent deficiency, TrueFFS uses M-Systems' patented wear-leveling algorithm. This wear-leveling algorithm ensures that consecutive writes of a specific sector are not written physically to the same page in the flash. This spreads flash media usage evenly across all pages, thereby maximizing flash lifetime.

### **Dynamic Wear-Leveling**

TrueFFS uses statistical allocation to perform dynamic wear-leveling on newly written data. This minimizes the number of erase cycles per block. Because a block erase is the most time-consuming operation, dynamic wear-leveling has a major impact on overall performance. This impact cannot be noticed during the first write to flash (since there is no need to erase blocks beforehand), but it is more and more noticeable as the flash media becomes full.

### **Static Wear-Leveling**

Areas on the flash media may contain static files, characterized by blocks of data that remain unchanged for very long periods of time, or even for the whole device lifetime. If wear-leveling were only applied on newly written pages, static areas would never be cycled. This limited application of wear-leveling would lower life expectancy significantly in cases where flash memory contains large static areas. To overcome this problem, TrueFFS forces data transfer in static areas as well as in dynamic areas, thereby applying wear-leveling to the entire media.

### **6.4.7 Power Failure Management**

TrueFFS uses algorithms based on "erase after write" instead of "erase before write" to ensure data integrity during normal operation and in the event of a power failure. Used areas are reclaimed for erasing and writing the flash management information into them only *after* an operation is complete. This procedure serves as a check on data integrity.

The "erase after write" algorithm is also used to update and store mapping information on the flash memory. This keeps the mapping information coherent even during power failures. The only mapping information held in RAM is a table pointing to the location of the actual mapping information. This table is reconstructed during power-up or after reset from the information stored in the flash memory.

To prevent data from being lost or corrupted, TrueFFS uses the following mechanisms:

- When writing, copying, or erasing the flash device, the data format remains valid at all intermediate stages. Previous data is never erased until the operation has been completed and the new data has been verified.
- A data sector cannot exist in a partially written state. The operation is either successfully completed, in which case the new sector contents are valid, or the operation has not yet been completed or has failed, in which case the old sector contents remain valid.

#### **6.4.8 Error Detection/Correction**

TrueFFS implements a unique MLC-tailored Error Correction Code (ECC) algorithm to ensure data reliability. Refer to Section 3.7 for further information on the EDC/ECC mechanism.

#### **6.4.9 Special Features through I/O Control (IOCTL) Mechanism**

In addition to standard storage device functionality, the TrueFFS driver provides extended functionality. This functionality goes beyond simple data storage capabilities to include features such as: formatting the media, read/write protection, boot partition(s) access, flash defragmentation and other options. This unique functionality is available in all TrueFFS-based drivers through the standard I/O control command of the native file system.

#### **6.4.10 Compatibility**

DiskOnChip G4 requires TrueFFS driver 6.3 or higher. Migrating from other than DiskOnChip G4 to DiskOnChip G4 requires changing the TrueFFS driver. TrueFFS 6.3 supports all DiskOnChip product lines including DiskOnChip G4/P4, DiskOnChip G3/P3, DiskOnChip H1 and DiskOnChip-based MCP.

When using different drivers (e.g. TrueFFS SDK, BDK, etc.) to access DiskOnChip G4, verify that all software is based on the same code base version. It is also important to use only tools (e.g. DFORMAT, DINFO, DIMAGE, etc.) from the same version as the TrueFFS drivers used in the application. Failure to do so may lead to unexpected results, such as lost or corrupted data. The driver version can be verified by the sign-on messages displayed, or by the version information presented by the driver or tool.

### **6.5 8KB Memory Window**

TrueFFS utilizes an 8KB memory window in the CPU address space, consisting of four 2KB sections as depicted in Figure 11. When in Reset mode, read cycles from sections 1 and 2 always return the value 00H to create a fixed and known checksum. When in Normal mode, these two sections are used for the internal registers. The 2KB Programmable Boot Block is in section 0 and section 3, to support systems that search for a checksum at the boot stage both from the top and bottom of memory. The addresses described here are relative to the absolute starting address of the 8KB memory window.

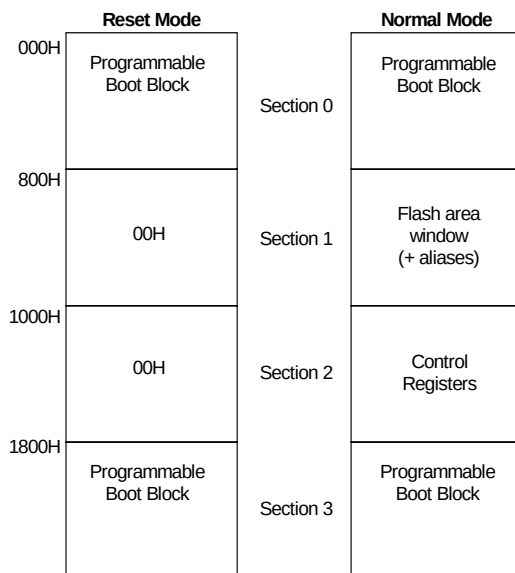


Figure 11: DiskOnChip G4 Memory Map

## 7. REGISTER DESCRIPTIONS

This section describes various DiskOnChip G4 registers and their functions, as listed in Table 3. Most DiskOnChip G4 registers are 8-bit, unless otherwise denoted as 16-bit.

*Table 3: DiskOnChip G4 Registers*

| Address (Hex) | Register Name                   |
|---------------|---------------------------------|
| 0030          | Paged RAM command               |
| 0070          | Paged RAM Select                |
| 0080          | Paged RAM Unique ID Download    |
| 100A          | Device ID Select                |
| 100C          | DiskOnChip Control              |
| 100E          | Configuration                   |
| 101C          | Burst Mode Control              |
| 103E          | No Operation (NOP)              |
| 107C          | DPD Control                     |
| 1000/1074     | Chip Identification [1:0]       |
| 1004          | Test                            |
| 1008          | Endian Control                  |
| 1010          | Interrupt Control               |
| 1014          | Output Control                  |
| 1020          | Interrupt Status                |
| 1024          | Virtual/Paged RAM status        |
| 1072          | DiskOnChip Control Confirmation |
| 1078/107A     | DMA Control [1:0]               |

### 7.1 Definition of Terms

The following abbreviations and terms are used within this section:

|             |                                                                                                                                                 |
|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------|
| RFU         | Reserved for future use. This bit is undefined during a read cycle and “don’t care” during a write cycle.                                       |
| RFU_0       | Reserved for future use; when read, this bit always returns the value 0; when written, software should ensure that this bit is always set to 0. |
| RFU_1       | Reserved for future use; when read, this bit always returns the value 1; when written, software should ensure that this bit is always set to 1. |
| Reset Value | Refers to the value immediately present after exiting from Reset mode to Normal mode.                                                           |

## 7.2 Reset Values

All registers return 00H while in Reset mode. The Reset value written in the register description is the register value after exiting Reset mode and entering Normal mode. Some register contents are undefined at that time (N/A).

## 7.3 RAM Page Command Register

**Description:** This 8-bit register is used to write the value 71H prior to writing to the RAM Page Select register.

**Address (hex):** 0030

**Type:** Write

|                    | D7      | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|--------------------|---------|----|----|----|----|----|----|----|
| <b>Read/Write</b>  | W       | W  | W  | W  | W  | W  | W  | W  |
| <b>Bit Name</b>    | COMMAND |    |    |    |    |    |    |    |
| <b>Reset Value</b> | N/A     |    |    |    |    |    |    |    |

| Bit No. | Description                                                                                                                           |
|---------|---------------------------------------------------------------------------------------------------------------------------------------|
| 0-7     | COMMAND The value 71H must be written to enable a subsequent write cycle to the RAM Page Select register. All other values: Reserved. |

## 7.4 RAM Page Select Register

**Description:** This 8-bit register is used to initiate a download operation of the specified 1KB page. If the value 71H is not written to the RAM Page Command register immediately before to writing this register, the write cycle will be ignored. This register is writeable in Reset mode.

**Address (hex):** 0070

**Type:** Write

|                    | D7  | D6   | D5 | D4 | D3 | D2 | D1 | D0 |
|--------------------|-----|------|----|----|----|----|----|----|
| <b>Read/Write</b>  | W   | W    | W  | W  | W  | W  | W  | W  |
| <b>Description</b> | SEQ | PAGE |    |    |    |    |    |    |
| <b>Reset Value</b> | N/A | 00H  |    |    |    |    |    |    |

| Bit No. | Description                                                                                                                                                           |
|---------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7       | SEQ (Sequential). Setting this bit initiates a download from the NEXT_PAGE pointer of the previously downloaded page. The value written to the PAGE field is ignored. |
| 0-6     | PAGE. Specifies the page to load. Only significant when writing a 0 to the SEQ field. A PAGE value of 00H loads the same data as a hardware or software reset.        |

## 7.5 Paged RAM Unique ID Download Register

**Description:** Writing to this 8 bit register initiates a download of the 16-byte Unique Identification (UID) number to offset 0 of the downloadable section of the IPL RAM .After polling for ready status, the requested data may be read from the IPL RAM.

Writes to this register will be ignored if the prior bus cycle was not a write cycle to the Paged RAM Command Register with data 71H (intervening RAM read cycles are allowed).

This register is writeable in Reset mode.

**Address (hex):** 0080

**Type:** Write

|                    |              |
|--------------------|--------------|
|                    | <b>D7-D0</b> |
| <b>Read/Write</b>  | W            |
| <b>Bit Name</b>    | RFU_0        |
| <b>Reset Value</b> | N/A          |

## 7.6 No Operation (NOP) Register

**Description:** A call to this 16-bit register results in no operation. To aid in code readability and documentation, software should access this register when performing cycles intended to create a time delay.

**Address (hex):** 103E

**Type:** Write

**Reset Value:** None

## 7.7 Chip Identification (ID) Register [0:1]

**Description:** These two 16-bit registers are used to identify the DiskOnChip device residing on the host platform. They always return the same value.

**Address (hex):** 1000/1074

**Type:** Read only

**Reset Value:** Chip Identification Register[0]: 0400H  
Chip Identification Register[1]: FBFFH

## 7.8 Test Register

**Description:** This register enables software to identify multiple DiskOnChip G4 devices or multiple aliases in the CPU's memory space. Data written is stored but does not affect the behavior of DiskOnChip G4.

**Address (hex):** 1004

**Type:** Read/Write

**Reset Value:** 0

| Bit No. | Description       |
|---------|-------------------|
| 7-0     | D[7:0]: Data bits |

## 7.9 Endian Control Register

**Description:** This 16-bit register is used to control the swapping of the low and high data bytes when reading or writing with a 16-bit host. This provides an Endian-independent method of enabling/disabling the byte swap feature.

**Note:** Hosts that support 8-bit access only do not need to write to this register.

**Address (hex):** 1008

|                    | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|--------------------|-------|-------|-------|-------|-------|-------|-------|-------|
| <b>Read/Write</b>  | R     |       |       |       |       |       |       | R/W   |
| <b>Description</b> | RFU_0 |       |       |       |       |       |       | SWAPL |
| <b>Reset Value</b> | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

|                    | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 |
|--------------------|--------|--------|--------|--------|--------|--------|-------|-------|
| <b>Read/Write</b>  | R      |        |        |        |        |        |       | R/W   |
| <b>Description</b> | RFU_0  |        |        |        |        |        |       | SWAPH |
| <b>Reset Value</b> | 0      | 0      | 0      | 0      | 0      | 0      | 0     | 0     |

| Bit No. | Description                                                                                                                  |
|---------|------------------------------------------------------------------------------------------------------------------------------|
| 0       | SWAPL (Swap Low Byte): This bit must be set to enable byte swapping. If the bit is cleared, then byte swapping is disabled.  |
| 7-1     | Reserved for future use.                                                                                                     |
| 8       | SWAPH (Swap High Byte): This bit must be set to enable byte swapping. If the bit is cleared, then byte swapping is disabled. |
| 15-9    | Reserved for future use.                                                                                                     |



## 7.10 DiskOnChip Control Register/Control Confirmation Register

**Description:** These two registers are identical and contain information about the DiskOnChip G4 operational mode. After writing the required value to the DiskOnChip Control register, the complement of that data byte must also be written to the Control Confirmation register. The two writes cycles must not be separated by any other read or write cycles to the DiskOnChip G4 memory space, except for reads from the Programmable Boot Block space.

**Address (hex):** 100C/1072

| Bit No             | Bit 7 | Bit 6 | Bit 5 | Bit 4   | Bit 3 | Bit 2  | Bit 1     | Bit 0 |
|--------------------|-------|-------|-------|---------|-------|--------|-----------|-------|
| <b>Read/Write</b>  | R     | R     | R/W   | R/W     | R/W   | R/W    | R/W       | R/W   |
| <b>Description</b> | RFU_0 |       |       | RST_LAT | BDET  | MDWREN | Mode[1:0] |       |
| <b>Reset Value</b> | 0     | 0     | 0     | 1       | 0     | 0      | 0         | 0     |

**Note:** The DiskOnChip Control Confirmation register is write only

| Bit No. | Description                                                                                                                                                                                                                        |
|---------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1-0     | Mode. These bits select the mode of operation, as follows:<br>00: Reset<br>01: Normal<br>10: Deep Power-Down                                                                                                                       |
| 2       | MDWREN (Mode Write Enable). The value 1 must be written to this bit when changing the mode of operation. It always returns 0 when read.                                                                                            |
| 3       | BDET (Boot Detect). This bit is set whenever the device has entered Reset mode as a result of the Boot Detector triggering. It is cleared by writing a 1 to this bit.                                                              |
| 4       | RST_LAT (Reset Latch). This bit is set whenever the device has entered the Reset mode as a result of the RSTIN# input signal being asserted or the internal voltage detector triggering. It is cleared by writing a 1 to this bit. |
| 7-5     | Reserved for future use.                                                                                                                                                                                                           |

## 7.11 Device ID Select Register

**Description:** In a cascaded configuration, this register controls which device provides the register space. The value of bits ID[0:1] is compared to the value of the ID configuration input pins/balls. The device whose ID input matches the value of bits ID[0:1] responds to read and write cycles.

**Address (hex):** 100A

|                    | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1   | Bit 0 |
|--------------------|-------|-------|-------|-------|-------|-------|---------|-------|
| <b>Read/Write</b>  | R     |       |       |       |       |       | R/W     |       |
| <b>Description</b> | RFU_0 |       |       |       |       |       | ID[1:0] |       |
| <b>Reset Value</b> | 0     | 0     | 0     | 0     | 0     | 0     | 0       | 0     |

| Bit No. | Description                                                                                                                                         |
|---------|-----------------------------------------------------------------------------------------------------------------------------------------------------|
| 1-0     | ID[1:0] (Identification). The device whose ID input pins/balls match the value of bits ID[0:1] responds to read and write cycles to register space. |
| 7-2     | Reserved for future use.                                                                                                                            |

## 7.12 Configuration Register

**Description:** This register indicates the current configuration of DiskOnChip G4. Unless otherwise noted, the bits are reset only by a hardware reset, and not upon boot detection or any other entry to Reset mode.

**Address (hex):** 100E

|                    | Bit 7  | Bit 6 | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0   |
|--------------------|--------|-------|--------|-------|-------|-------|-------|---------|
| <b>Read/Write</b>  | R      |       | R/W    |       | R     |       |       |         |
| <b>Description</b> | IF_CFG | RFU_0 | MAX_ID |       | RFU   | RFU_0 |       | VCCQ_3V |
| <b>Reset Value</b> | X      | 0     | 0      | 0     | 0     | 0     | 0     | X       |

| Bit No. | Description                                                                                                                                                                                                                                                                                                                       |
|---------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0       | VCCQ_3V: Reflects the level of VCCQ input.<br>0: VCCQ < 2.0V<br>1: VCCQ > 2.5V                                                                                                                                                                                                                                                    |
| 6, 3-1  | Reserved for future use.                                                                                                                                                                                                                                                                                                          |
| 5-4     | MAX_ID (Maximum Device ID). This field controls the Programmable Boot Block address mapping when multiple devices are used in a cascaded configuration, using the ID[1:0] inputs. It should be programmed to the highest ID value that is found by software in order to map all available boot blocks into usable address spaces. |
| 7       | IF_CFG (Interface Configuration). Reflects the state of the IF_CFG input pin.                                                                                                                                                                                                                                                     |

## 7.13 Interrupt Control Register

**Description:** This 16-bit register controls how interrupts are generated by DiskOnChip G4, and indicates which of the following five sources has asserted an interrupt:

- 0: Flash array is ready
- 1: Data protection violation
- 2: Reading or writing more flash data than was expected
- 3: BCH ECC error detected (this feature is provided to support multi-page DMA transfers)
- 4: Completion of a DMA operation

**Address (hex):** 1010

|                    | Bit 7 | Bit 6 | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|--------------------|-------|-------|--------|-------|-------|-------|-------|-------|
| <b>Read/Write</b>  | R     |       | R/W    |       |       |       |       |       |
| <b>Description</b> | RFU_0 |       | ENABLE |       |       |       |       |       |
| <b>Reset Value</b> | 0     | 0     | 0      | 0     | 0     | 0     | 0     | 0     |

|                    | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 |
|--------------------|--------|--------|--------|--------|--------|--------|-------|-------|
| <b>Read/Write</b>  | R/W    |        |        |        |        |        |       |       |
| <b>Description</b> | GMASK  | EDGE   | MASK   |        |        |        |       |       |
| <b>Reset Value</b> | 0      | 0      | 0      | 0      | 0      | 0      | 0     | 0     |

| Bit No. | Description                                                                                                                                                                                                                                                                                                                                                                                                                            |
|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 5-0     | ENABLE. For each bit in this field:<br><b>1:</b> Enables the respective bit in the STATUS field of the Interrupt Status register to latch activity and cause an interrupt if the corresponding MASK bit is set.<br><b>0:</b> Holds the respective bit in the STATUS field in the cleared state. To clear a pending interrupt and re-enable further interrupts on that channel, the respective ENABLE bit must be cleared and then set. |
| 7-6     | Reserved for future use.                                                                                                                                                                                                                                                                                                                                                                                                               |
| 13-8    | MASK. For each bit in this field:<br><b>1:</b> Enables the respective bit in the STATUS field of the Interrupt Status register to generate an interrupt by asserting the IRQ# output.<br><b>0:</b> Prevents the respective STATUS bit from generating an interrupt.                                                                                                                                                                    |
| 14      | EDGE. Selects edge or level triggered interrupts:<br><b>0:</b> Specifies level-sensitive interrupts in which the IRQ# output remains asserted until the interrupt is cleared.<br><b>1:</b> Specifies edge-sensitive interrupts in which the IRQ# output pulses low and return to logic 1.                                                                                                                                              |

| Bit No. | Description                                                                                                                                                                                                               |
|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15      | GMASK (Global Mask).<br><b>1:</b> Enables the IRQ# output to be asserted. Setting this bit while one or more interrupts are pending will generate an interrupt.<br><b>0:</b> Forces the IRQ# output to the negated state. |

## 7.14 Interrupt Status Register

Description: This register indicates which interrupt source created an interrupt.

Address (hex): 1020

|             | Bit 7 | Bit 6 | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------------|-------|-------|--------|-------|-------|-------|-------|-------|
| Read/Write  | R     |       | R/W    |       |       |       |       |       |
| Description | RFU_0 |       | STATUS |       |       |       |       |       |
| Reset Value | 0     | 0     | 0      | 0     | 0     | 0     | 0     | 0     |

| Bit No. | Description                                                                                                                                                             |
|---------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 5-0     | STATUS. Indicates which interrupt sources created an interrupt. For a list of the interrupt sources, please refer to the description of the Interrupt Control register. |
| 7-6     | Reserved for future use.                                                                                                                                                |

## 7.15 Output Control Register

Description: This register controls the behavior of certain output signals. This register is reset by a hardware reset, not by entering Reset mode.

Note: When multiple devices are cascaded, writing to this register will affect all devices regardless of the value of the ID[1:0] inputs.

Address (hex): 1014

|             | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1  | Bit 0   |
|-------------|-------|-------|-------|-------|-------|-------|--------|---------|
| Read/Write  | R     |       |       |       |       | R/W   |        |         |
| Description | RFU_0 |       |       |       |       | Turbo | PU_DIS | BUSY_EN |
| Reset Value | 0     | 0     | 0     | 0     | 0     | 0     | 0      | 1       |

| Bit No. | Description                                                                                                                                                                                                                                                                                                               |
|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0       | BUSY_EN (Busy Enable). Controls the assertion of the BUSY# output during a download initiated by a soft reset.<br><b>1:</b> Enables the assertion of the BUSY# output<br><b>0:</b> Disables the assertion of the BUSY# output<br>Upon the assertion of the RSTIN# input, this bit will be set automatically and the BUSY# |

|     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|     | output signal will be asserted until the completion of the download process.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 1   | PU_DIS (Pull-Up Disable). Controls the pull-up resistors D[15:8] as follows:<br><b>1:</b> Always disable the pull-ups<br><b>0:</b> Enable the pull-ups when IF_CFG = 0                                                                                                                                                                                                                                                                                                                                                                                                        |
| 2   | TURBO. Activates turbo operation.<br><b>0:</b> DiskOnChip is used in normal operation, without improved access time. Output buffers are enabled only after a long enough delay to guarantee that there will be no more than a single transition on each bit.<br><b>1:</b> DiskOnChip is used in Turbo operation. Output buffers are enabled immediately after the assertion of OE# and CE#, resulting in improved access time. Read cycles from the Programmable Boot Block may result in additional noise and power dissipation due to multiple transitions on the data bus. |
| 7-3 | Reserved for future use.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

## 7.16 DPD Control Register

Description: This register specifies the behavior of the DPD input signal.

Address (hex): 107C

|                    | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3     | Bit 2 | Bit 1 | Bit 0 |
|--------------------|-------|-------|-------|-------|-----------|-------|-------|-------|
| <b>Read/Write</b>  | R     |       |       |       | R/W       |       |       |       |
| <b>Description</b> | PD_OK | RFU_0 |       |       | MODE[0:3] |       |       |       |
| <b>Reset Value</b> | 0     | 0     | 0     | 0     | 0         | 0     | 0     | 0     |

| Bit No. | Description                                                                                                                                                                                                                                                                                                                                  |
|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 3-0     | MODE[0:3]. Controls the behavior of the DPD input:<br>0000: DPD input is not used to control DPD mode<br>0001: DPD mode exited on rising edge of DPD input<br>0010: DPD mode exited on falling edge of DPD input<br>0100: DPD mode is entered when DPD=1 and exited when DPD=0<br>1000: DPD mode is entered when DPD=0 and exited when DPD=1 |
| 6-4     | Reserved for future use.                                                                                                                                                                                                                                                                                                                     |
| 7       | PD_OK (Power- Down OK). This read-only bit indicates that it is currently possible to put DiskOnChip G4 in Deep Power-Down mode.                                                                                                                                                                                                             |

## 7.17 DMA Control Register [1:0]

Description: These two 16-bit registers specify the behavior of the DMA operation.

Address (hex): 1078/107A

| DMA Control Register [o] |       |              |       |       |       |       |       |       |
|--------------------------|-------|--------------|-------|-------|-------|-------|-------|-------|
|                          | Bit 7 | Bit 6        | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| Read/Write               | R     | R/W          |       |       |       |       |       |       |
| Description              | RFU_0 | SECTOR_COUNT |       |       |       |       |       |       |
| Reset Value              | 0     | 0            | 0     | 0     | 0     | 0     | 0     | 0     |

|             | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 |
|-------------|--------|--------|--------|--------|--------|--------|-------|-------|
| Read/Write  | R      | R/W    |        |        | R      |        |       |       |
| Description | DMA_EN | PAUSE  | EDGE   | POLRTY | RFU_0  |        |       |       |
| Reset Value | 0      | 0      | 0      | 0      | 0      | 0      | 0     | 0     |

| Bit No. | Description                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|---------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 6-0     | SECTOR_COUNT. Specifies the number of 512-byte sectors to be transferred plus one. Writing a value of 0 indicates a transfer of one sector. Reading a value of 0 indicates that there is still one sector to be transferred). This field is decremented by DiskOnChip G4 after reading the ECC checksum from each sector. In the event of an ECC error, this field indicates the number of sectors remaining to be transferred.                     |
| 11-7    | Reserved for future use.                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 12      | POLRTY (Polarity). Specifies the polarity of the DMARQ# output:<br><b>0:</b> DMARQ# is normally logic -1 and falls to initiate DMA<br><b>1:</b> DMARQ# is normally logic -0 and rises to initiate DMA                                                                                                                                                                                                                                               |
| 13      | EDGE. Controls the behavior of the DMARQ# output:<br><b>1:</b> DMARQ# pulses to the asserted state for 250 nS (typical) to initiate the block transfer.<br><b>0:</b> DMARQ# switches to the active state to initiate the block transfer and returns to the negated state at the beginning of the cycle in which the DCNT field of the ECC Control register[0] reaches the value specified by the NEGATE_COUNT field of the DMA Control register[1]. |
| 14      | PAUSE. This bit is set in the event of an ECC error during a DMA operation. After reading the ECC parity registers and correcting the errors, the software must clear this bit to resume the DMA operation.                                                                                                                                                                                                                                         |
| 15      | DMA_EN (DMA Enable). Setting this bit enables DMA operation.                                                                                                                                                                                                                                                                                                                                                                                        |

| DMA Control Register [1] |            |   |   |   |              |   |   |   |
|--------------------------|------------|---|---|---|--------------|---|---|---|
|                          | Bits 15-10 |   |   |   | Bits 9-0     |   |   |   |
| Read/Write               | R          |   |   |   | R/W          |   |   |   |
| Description              | RFU_0      |   |   |   | NEGATE_COUNT |   |   |   |
| Reset Value              | 0          | 0 | 0 | 0 | 0            | 0 | 0 | 0 |

| Bit No. | Description                                                                                                                                                                                                                                                                                                                                                                                 |
|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 9-0     | NEGATE_COUNT. When the EDGE bit of the DMA Control register[0] is 0, this field must be programmed to specify the bus cycle in which DMARQ# will be negated, as follows:<br>NEGATE_COUNT = BYTES_REMAINING + 16 + BYTES_PER_CYCLE.<br>Example: To negate DMARQ# at the beginning of the cycle in which the last word is to be transferred by a 16-bit host: NEGATE_COUNT = 2 + 16 + 2 = 20. |
| 15-10   | Reserved for future use.                                                                                                                                                                                                                                                                                                                                                                    |

## 7.18 MultiBurst Mode Control Register

Description: This 16-bit register controls the behavior of DiskOnChip G4 during MultiBurst mode read cycles.

Address (hex): 101C

|             | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1   | Bit 0  |
|-------------|-------|-------|-------|-------|-------|-------|---------|--------|
| Read/Write  | R     |       | R     | R     | R     | R/W   |         |        |
| Description | RFU_0 |       | LATPI | EBRA  | FIFO  | HOLD  | CLK_INV | BST_EN |
| Reset Value | 0     | 0     | 0     | 0     | 0     | 0     | 0       | 0      |

|             | Bit 15 | Bit 14 | Bit 13 | 12 | Bit 11  | Bit 10 | Bit 9 | Bit 8 |
|-------------|--------|--------|--------|----|---------|--------|-------|-------|
| Read/Write  | R/W    |        |        |    |         |        |       |       |
| Description | LENGTH |        |        |    | LATENCY |        |       |       |
| Reset Value | 0      | 0      | 0      | 0  | 0       | 0      | 0     | 0     |

| Bit No. | Description                                                                                                                                                                                                                                          |
|---------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0       | BST_EN (MultiBurst Mode Enable). Enables MultiBurst mode read cycles.<br>0: The CLK input is disabled and may be left floating. Burst read cycles are not supported.<br>1: The CLK input is enabled. Subsequent read cycles must be MultiBurst mode. |
| 1       | CLK_INV (Clock Invert). Selects the edge of the CLK input on which CE# and OE# are sampled.<br>0: CE# and OE# are sampled on the rising edge of CLK.<br>1: CE# and OE# are sampled on the falling edge of CLK, and there will be an additional ½     |

|       |                                                                                                                                                                                                                                                                                                                                |
|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|       | clock delay from CE#/OE# asserted until the first data word may be latched on D[15:0].                                                                                                                                                                                                                                         |
| 2     | HOLD. Specifies if the data output on D[15:0] during MultiBurst mode read cycles should be held for an additional clock cycle.<br><b>0:</b> Data on the D[15:0] outputs is held for one clock cycle<br><b>1:</b> Data on the D[15:0] outputs is held for two clock cycles                                                      |
| 3     | FIFO. Enables FIFO mode which supports higher CLK frequencies but imposes limitations on LENGTH and LATENCY. This bit must not be set if HOLD=1                                                                                                                                                                                |
| 4     | EBRA (Exit Burst on RAM Access). Enables asynchronous sampling of A[12:11] at the start of each cycle. If a RAM read access is detected while EBRA is set, then BST_EN will be negated and the RAM access will be completed asynchronously                                                                                     |
| 5     | LATPI (Latency Plus 1). Externally, setting this bit is equivalent to adding an additional clock cycle of latency. Internally, however, it eliminates a critical timing path which occurs when FIFO=1 and EBRA=1.                                                                                                              |
| 6-7   | Reserved for future use.                                                                                                                                                                                                                                                                                                       |
| 8-11  | LATENCY. Controls the number of clock cycles between when DiskOnChip G4 samples OE# and CE# asserted and the first word of data is available to be latched by the host. This number of clock cycles is equal to 2 + LATECNCY. If HOLD = 1, then the data is available to be latched on this clock and on the subsequent clock. |
| 12-15 | LENGTH. Specifies the number of byte/words (depending on IF_CFG) to be transferred in each burst cycle:<br>HOLD=0: Number of bytes/words = $2^{\text{LENGTH}}$<br>HOLD=1: Number of bytes/words = $2^{\text{(LENGTH - 1)}}$<br>Note: The maximum value of LENGTH is 10.                                                        |

## 7.19 Virtual/Paged RAM Status Register

**Description:** The 3 LSBs of this 8 bit register indicate the value of the Virtual/Paged RAM status byte. This register also provides a means of temporarily disabling Virtual RAM downloads to permit polling for ready status after a software reset.

**Address (hex):** 1024

|                    | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3  | Bit 2  | Bit 1   | Bit 0 |
|--------------------|-------|-------|-------|-------|--------|--------|---------|-------|
| <b>Read/Write</b>  | R     | R     | R     | R     | RW     | R      | R       | R     |
| <b>Description</b> | VRS   | RFU_0 |       |       | VR_DIS | RFU    | ALT_MAP | VR_EN |
| <b>Reset Value</b> | 1     | 0     | 0     | 0     | 0      | Varies |         |       |

| Bit No. | Description                                                                                                              |
|---------|--------------------------------------------------------------------------------------------------------------------------|
| 0       | VR_EN [Virtual RAM Enable] Indicates that Virtual RAM is enabled.                                                        |
| 1       | ALT_MAP [Alternate Memory Map]<br>VR_EN = 1: Controls initial data in RAM after a hardware or software reset as follows: |



|   |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|---|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|   | <p>0: The bottom 2KB of data (IPL pages 0-3) are loaded.</p> <p>1: The top 2KB of data (IPL pages 12-15) are loaded.</p> <p>Setting this bit does not affect the mapping of data from the flash to RAM, or the order of bytes in RAM.</p> <p>VR_EN = 0: Swaps the fixed and downloadable 1KB sections of the RAM as follows:</p> <p>0: 1KB page starting at 0000H (aliased to 1800H) is fixed, 1KB page starting at 0400H (aliased to 1C00H) is downloadable via Paged RAM command sequence.</p> <p>1: 1KB page starting at 0400H (aliased to 1C00H) is fixed, 1KB page starting at 0000H (aliased to 1800H) is downloadable via Paged RAM command sequence. After the initial download, the data in the upper and lower 1KB pages is swapped compared to the case of Alternate Memory Map = 0.</p> |
| 3 | VR_DIS [Virtual RAM Disable] Setting this bit prevents Virtual RAM downloads from occurring. This feature may be set prior to a software reset in order to allow polling the Download Status Register for ready status without triggering an unwanted Virtual RAM download. After the software reset is complete, this bit must be cleared to allow subsequent Virtual RAM downloads, i.e. warm boot                                                                                                                                                                                                                                                                                                                                                                                                |
| 7 | VRS [Virtual RAM Supported] This read-only bit returns a 1 to indicate a device which supports Virtual RAM mode.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |

## **8. BOOTING FROM DISKONCHIP G4**

### **8.1 Introduction**

DiskOnChip G4 can function both as a flash disk and as the system boot device..

If DiskOnChip G4 is configured as a flash disk and as the system boot device, it contains the boot loader, an OS image and a file system. In such a configuration, DiskOnChip G4 can serve as the only non-volatile device on board.

### **8.2 Boot Replacement**

In legacy architecture the boot code is executed from a boot ROM, and the drivers are usually loaded from the storage device.

When using DiskOnChip G4 as the system boot device, the CPU fetches the first instructions from the DiskOnChip G4 Programmable Boot Block, which contains the IPL. Since in most cases this block cannot hold the entire boot loader, the IPL runs minimum initialization, after which the Secondary Program Loader (SPL) is copied to RAM from flash. The remainder of the boot loader code then runs from RAM.

The SPL is located in a separate (binary) partition on DiskOnChip G4, and can be hardware protected if required.

#### **8.2.1 Asynchronous Boot Mode**

Platforms that host CPUs that wake up in MultiBurst mode should use Asynchronous Boot mode when using DiskOnChip G4 as the system boot device.

During platform initialization, certain CPUs wake up in 32-bit mode and issue instruction fetch cycles continuously. An Intel XScale CPU, for example, initiates a 16-bit read cycle, but after the first word is read, it continues to hold CE# and OE# asserted while it increments the address and reads additional data as a burst.

Once in Asynchronous Boot mode, the CPU can fetch its instruction cycles from the DiskOnChip G4 Programmable Boot Block. After reading from this block and completing boot, DiskOnChip G4 returns to derive its internal clock signal from the CE#, OE#, and WE# inputs. Please refer to Section 10.3 for read timing specifications for Asynchronous Boot mode.

#### **8.2.2 Virtual RAM Boot**

The Virtual RAM Boot feature utilizes the 2KB physical IPL SRAM to provide XIP access to up to 8KB of flash data, without requiring any prior knowledge of the device architecture. This feature can be used to support the Processor Secure Boot requirements. The Virtual RAM Boot feature is intended for platforms that support the DiskOnChip G4 BUSY# output.

When DiskOnChip G4 is configured with the Virtual RAM Boot feature active, DiskOnChip remains in virtual RAM whenever it is in Reset mode. While in this mode, read cycles from the entire DiskOnChip 8KB memory window return virtual RAM data. Access to an address that is not the physical 2KB SRAM initiates a download operation in which the required data is copied from the NAND flash to the physical SRAM. The DiskOnChip BUSY# output is asserted (low) for the

duration of the download, to indicate that the data is not ready, holding the platform in a wait state. When the download is completed the /BUSY line will be negated (high). This handshake mechanism is compatible with CPU bus controllers that support automatic insertion of wait states based on the state of a /RDY signal. The platform must be capable of being held in a wait state for an arbitrary period during each download process, without interference from watchdog timers.

The download is transparent to software, and XIP and random access from any location within the 8KB virtual address space are therefore supported.

For more information on how to boot from DiskOnChip G4 in Virtual RAM Boot mode, please contact your local M-Systems sales office

### **8.2.3 Paged RAM Boot**

The Paged RAM Boot feature separates the 2KB IPL SRAM into two 1KB sections. The first section provides constant data, while the other section can be downloaded with flash data. One application of this feature is to support the processors Secure Boot requirements. The Paged RAM Boot feature does not support XIP (unlike the Virtual RAM Boot feature), but also does not require support of the BUSY# output.

After a hardware or software reset, DiskOnChip G4 initializes the first 2KB of RAM from data stored in a fixed location on DiskOnChip G4. The Paged RAM Boot feature permits 1KB of the internal SRAM to be downloaded upon receiving a command sequence from one of many 1KB virtual pages (up to 124 sections of 2KB). Since the DiskOnChip G4 BUSY# output is not asserted by a page-load operation, a polling procedure is required to determine when the download is complete. A XIP operation from the DiskOnChip G4 RAM is not supported during this polling operation, so it must be executed instead from system RAM or ROM.

Normally, the data in the first 1KB of RAM is fixed, while the second 1 KB is downloaded upon command.

To support platforms that boot from the top rather than the bottom of memory, DiskOnChip G4 can be configured with an alternate memory map where the top 1KB of the DiskOnChip G4 address space returns fixed RAM data, while the 1KB below that is downloadable.

When multiple DiskOnChip G4 devices are cascaded, Paged RAM downloads occur only on the first DiskOnChip in the cascaded configuration (device-0). The other cascaded devices move to Reset mode when a Paged RAM download is initiated.

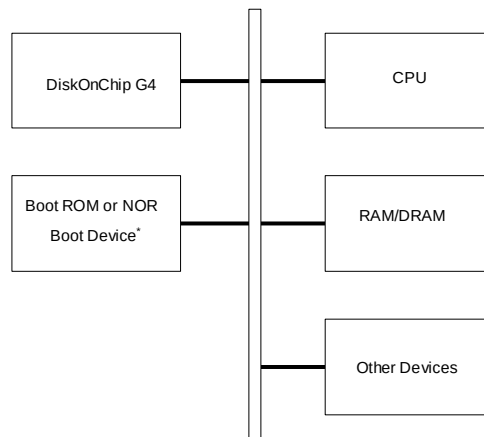
For more information on booting from DiskOnChip G4 in Paged RAM Boot mode, please contact your local M-Systems sales office.

## 9. DESIGN CONSIDERATIONS

### 9.1 General Guidelines

A typical RISC processor memory architecture is shown in Figure 12. It may include the following devices:

- **DiskOnChip G4:** Contains the OS image, applications, registry entries, back-up data, user files and data, etc. It can also be used to perform boot operation, thereby replacing the need for a separate boot device.
- **CPU:** DiskOnChip G4 is compatible with all major CPUs in the mobile phone, Digital TV (DTV) and Digital Still Camera (DSC) markets, including:
  - ARM-based CPUs
  - Texas Instruments OMAP, DBB
  - Intel XScale PXAxxx family
  - Infineon xGold family
  - Analog Devices (ADI) AD652x family
  - Freescale MX family
  - Zoran ER4525
  - Renesas SH mobile
  - Qualcomm MSMxxxx
  - AMD Alchemy
  - Motorola PowerPC™ MPC8xx
  - Hitachi SuperH™ SH-x
- **Boot Device:** ROM or NOR flash that contains the boot code required for system initialization, kernel relocation, loading the operating systems and/or other applications and files into the RAM and executing them.
- **RAM/DRAM Memory:** This memory is used for code execution.
- **Other Devices:** A DSP processor, for example, may be used in a RISC architecture for enhanced multimedia support.

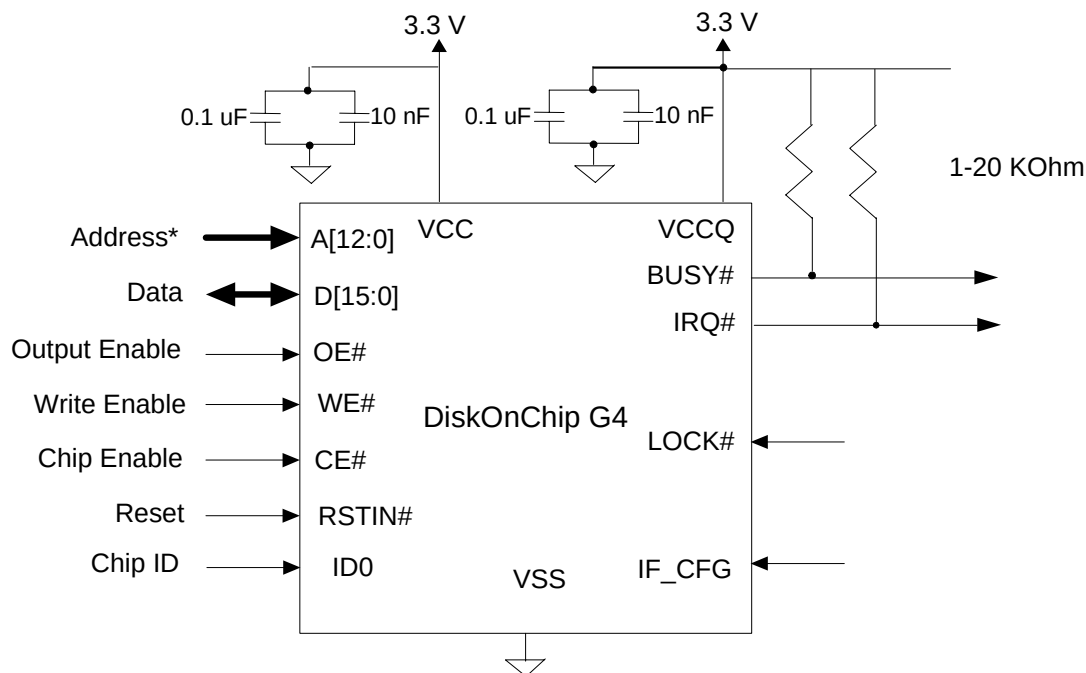


When used as a boot device, DiskOnChip G4 eliminates the need for a dedicated boot ROM/NOR device.

*Figure 12: Typical System Architecture Using DiskOnChip G4*

## 9.2 Standard NOR-Like Interface

DiskOnChip G4 uses a NOR-like interface that can easily be connected to any microprocessor bus. With a standard interface, it requires 13 address lines, 8 data lines and basic memory control signals (CE#, OE#, WE#), as shown in Figure 13 below. Typically, DiskOnChip G4 can be mapped to any free 8KB memory space.



(\*) Address A0 is multiplexed with the DPD signal.

*Figure 13: Standard System Interface*

- Notes:
1. The 0.1  $\mu$ F and the 10 nF low-inductance, high-frequency capacitors must be attached to each of the device's VCC and VSS balls. These capacitors must be placed as close as possible to the package leads.
  2. DiskOnChip G4 is an edge-sensitive device. CE#, OE#, and WE# should be properly terminated (according to board layout, serial parallel or both terminations) to avoid signal ringing.

## 9.3 Multiplexed Interface

With a multiplexed interface, DiskOnChip G4 requires the signals shown in Figure 14 below.

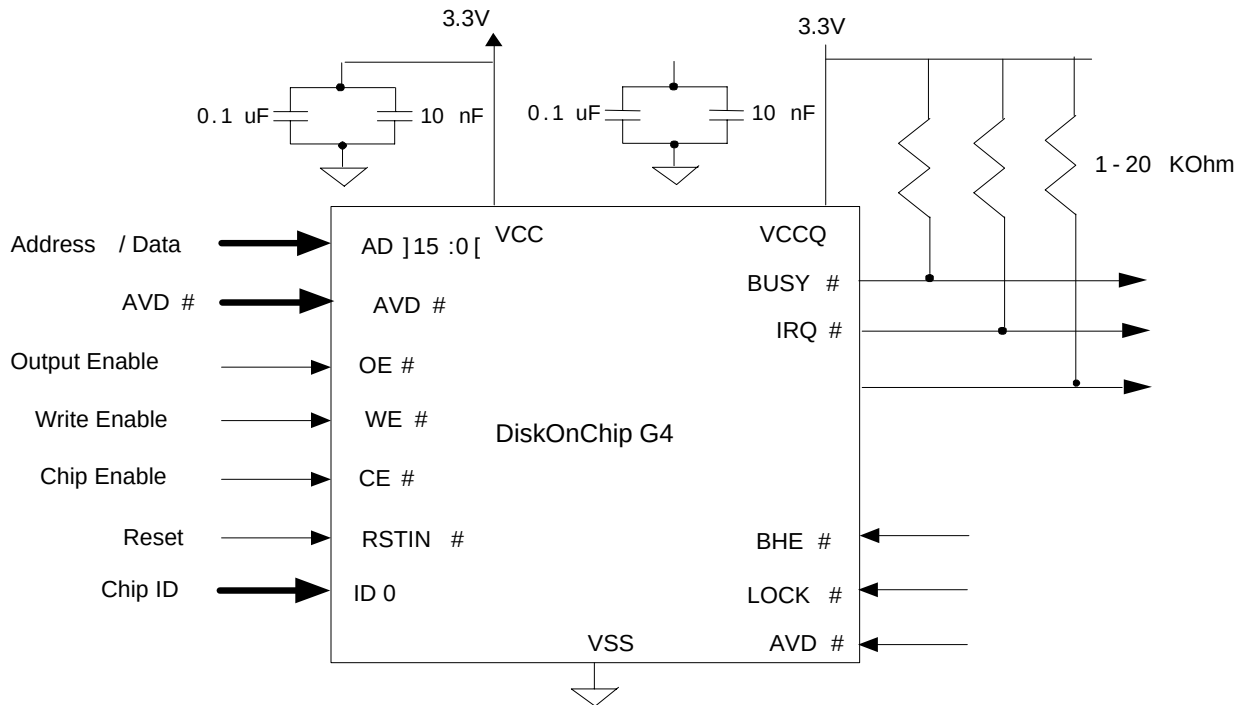


Figure 14: Multiplexed System Interface

Notes: 1. The 0.1  $\mu$ F and the 10 nF low-inductance, high-frequency capacitors must be attached to each of the device's VCC and VSS balls. These capacitors must be placed as close as possible to the package leads.

## 9.4 Connecting Control Signals

### 9.4.1 Standard Interface

When using a standard NOR-like interface, connect the control signals as follows:

- A[12:0] – Connect these signals to the host's address signals (see Section 9.8 for platform-related considerations). Address signal A[0] is multiplexed with the DPD signal.
- D[15:0] – Connect these signals to the host's data signals (see Section 9.8 for platform-related considerations).
- Output Enable (OE#) and Write Enable (WE#) – Connect these signals to the host RD# and WR# signals, respectively.
- Chip Enable (CE#) – Connect this signal to the memory address decoder. Most RISC processors include a programmable decoder to generate various Chip Select (CS) outputs for

different memory zones. These CS signals can be programmed to support different wait states to accommodate DiskOnChip G4 timing specifications.

- Power-On Reset In (RSTIN#) – Connect this signal to the host active-low Power-On Reset signal.
- Chip Identification (ID[1:0]) – Connect these signals as shown in Figure 13. Both signals must be connected to VSS if the host uses only one DiskOnChip. If more than one device is being used, refer to Section 9.6 for more information on device cascading.
- Busy (BUSY#) – This signal indicates when the device is ready for first access after reset. It may be connected to an input port of the host, or alternatively it may be used to hold the host in a wait-state condition. The later option is required for hosts that boot from DiskOnChip G4.
- DMARQ# (DMA Request) – Output used to control multi-page DMA operations. Connect this output to the DMA controller of the host platform.
- IRQ# (Interrupt Request) – Connect this signal to the host interrupt.
- Lock (LOCK#) – Connect to a logical **0** to prevent the usage of the protection key to open a protected partition. Connect to logical **1** in order to enable usage of protection keys.
- Deep-Power Down (DPD) – multiplexed with A[0].
- 8/16 Bit Interface Configuration (IF\_CFG) – This signal is required for configuring the device for 8- or 16-bit access mode. When negated, the device is configured for 8-bit access mode. When asserted, 16-bit access mode is operative.
- Clock (CLK) – This input is used to support MultiBurst operation when reading flash data. Refer to Section 4.1 for further information on MultiBurst operation.

#### 9.4.2 Multiplexed Interface

DiskOnChip G4 can use a multiplexed interface to connect to the multiplexed bus (asynchronous read/write protocol). In this configuration, the ID[1] input is driven by the host's AVD# signal, and the D[15:0] pins/balls, used for both address inputs and data, are connected to the host AD[15:0] bus. As with a standard interface, only address bits [12:0] are significant.

This mode is automatically entered when a falling edge is detected on ID[1]. This edge must occur after RSTIN# is negated and before OE# and CE# are both asserted; i.e., the first read cycle made to DiskOnChip must observe the multiplexed mode protocol. See Section 10.3 for more information about the related timing requirements.

Please refer to Section 2.3 for pinout and signal descriptions, and to Section 10.3 for timing specifications for a multiplexed interface.



## 9.5 Implementing the Interrupt Mechanism

### 9.5.1 Hardware Configuration

To configure the hardware for working with the interrupt mechanism, connect the IRQ# pin/ball to the host interrupt input.

Note: A nominal 10 K $\Omega$  pull-up resistor must be connected to this pin/ball.

### 9.5.2 Software Configuration

Configuring the software to support the IRQ# interrupt is performed in two stages.

#### Stage 1

Configure the software so that when the system is initialized, the following steps occur:

1. The correct value is written to the Interrupt Control register to configure DiskOnChip G4 for:
  - Interrupt source: Flash ready, data protection, last byte during DMA has been transferred, or BCH ECC error has been detected (used during multi-page DMA operations).
  - Output sensitivity: Either edge or level-triggered

Note: Refer to Section 7 for further information on the value to write to this register.

2. The host interrupt is configured to the selected input sensitivity, either edge or level-triggered.
3. The handshake mechanism between the interrupt handler and the OS is initialized.
4. The interrupt service routine to the host interrupt is connected and enabled.

#### Stage 2

Configure the software so that for every long flash I/O operation, the following steps occur:

1. The correct value is written to the Interrupt Control register to enable the IRQ# interrupt.

Note: Refer to Section 7 for further information on the value to write to this register.

2. The flash I/O operation starts.
3. Control is returned to the OS to continue other tasks. When the IRQ# interrupt is received, other interrupts are disabled and the OS is flagged.
4. The OS either returns control immediately to the TrueFFS driver, or waits for the appropriate condition to return control to the TrueFFS driver.

## 9.6 Device Cascading

When connecting DiskOnChip G4 128MB (1Gb) using a standard interface, up to four devices can be cascaded with no external decoding circuitry. Figure 15 illustrates the configuration required to cascade four devices on the host bus (only the relevant cascading signals are included in this figure, although all other signals must also be connected). All pins/balls of the cascaded devices must be wired in common, except for ID0 and ID1. The ID input pins/balls are strapped to VCC or VSS, according to the location of each DiskOnChip. The ID pin/ball values determine the identity of each device. For example, the first device is identified by connecting the ID pins/balls as 00, and the last device by connecting the ID pins/balls as 11. Systems that use only one DiskOnChip G4 128MB (1Gb) must connect the ID pins/balls as 00. Additional devices must be configured consecutively as 01, 10 and 11.

When DiskOnChip G4 128MB (1Gb) uses a multiplexed interface, the value of ID[1] is set to logic 0. Therefore, only two devices can be cascaded using ID[0].

DiskOnChip G4 256MB (2Gb) devices cannot be cascaded when using a multiplexed interface.

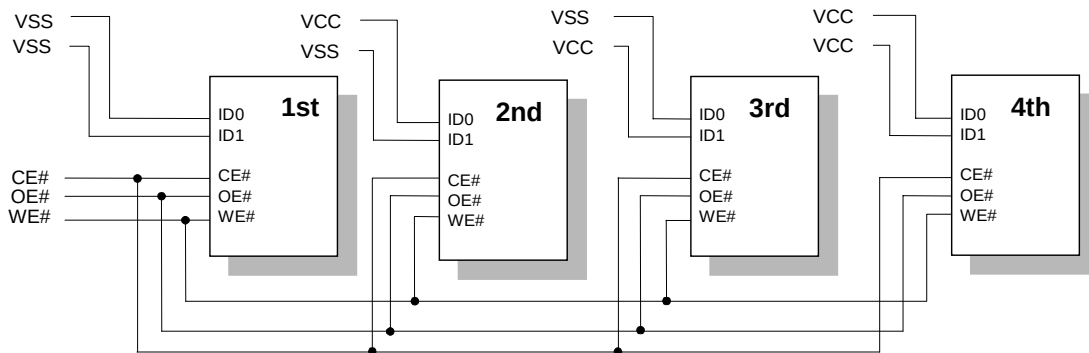


Figure 15: Standard Interface, Cascaded Configuration

## 9.7 Boot Replacement

A typical RISC architecture uses a boot ROM for system initialization. The boot ROM is also required to access DiskOnChip G4 during the boot sequence in order to load OS images and the device drivers.

M-Systems' Boot Software Development Kit (BDK) and DOS utilities enable full control of DiskOnChip G4 during the boot sequence. For a complete description of these products, refer to the *DiskOnChip Boot Software Development Kit (BDK)* developer guide and the *DiskOnChip Software Utilities* user manual. These tools enable the following operations:

- Formatting DiskOnChip G4
- Creating multiple partitions for different storage needs (OS images files, backup partitions, and FAT partitions)
- Loading the OS image file

Figure 16 illustrates an example of one system boot flow using DiskOnChip G4 in a RISC architecture.

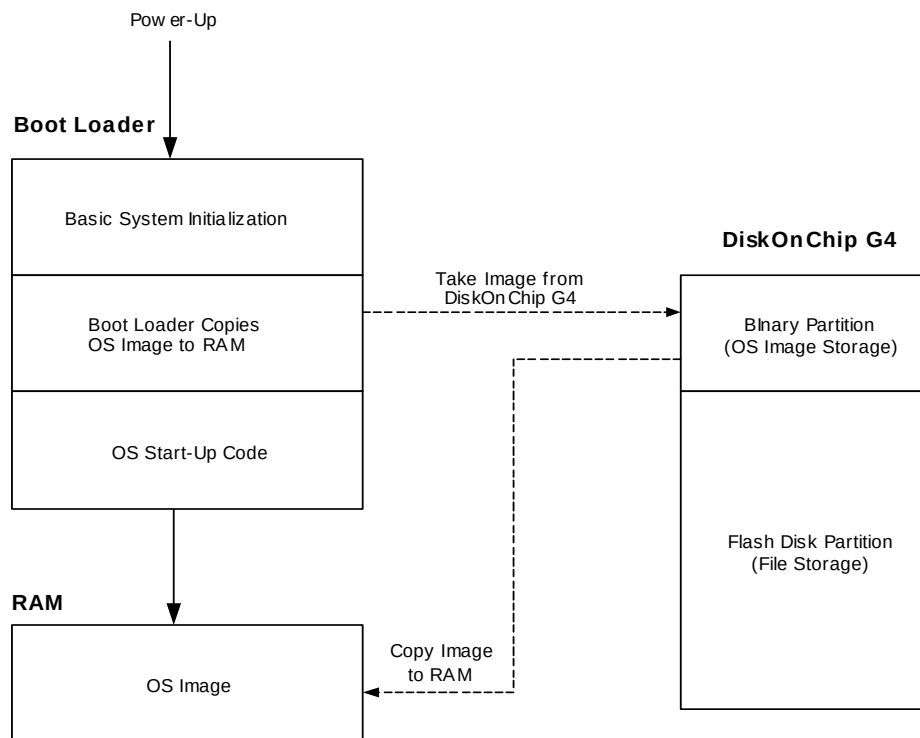


Figure 16: System Boot Flow with DiskOnChip G4

## 9.8 Platform-Specific Issues

This section discusses hardware design issues for major embedded RISC processor families.

### 9.8.1 Wait State

Wait states can be implemented only when DiskOnChip G4 is designed in a bus that supports a Wait state insertion, and supplies a WAIT signal.

### 9.8.2 Big and Little Endian Systems

DiskOnChip G4 is a Little Endian device. Therefore, byte lane 0 (D[7:0]) is its Least Significant Byte (LSB) and byte lane 1 (D[15:8]) is its Most Significant Byte (MSB). Within the byte lanes, bit D0 and bit D8 are the least significant bits of their respective byte lanes. DiskOnChip G4 can be connected to a Big Endian device in one of two ways:

1. Make sure to identify byte lane 0 and byte lane 1 of your processor. Then, connect the data bus so that the byte lanes of the CPU match the byte lanes of DiskOnChip G4. Pay special attention to processors that also change the bit ordering within the bytes (for example, PowerPC). Failing to follow these rules results in improper connection of DiskOnChip G4, and prevents the TrueFFS driver from identifying it.
2. Set the bits SWAPH and SWAPL in the Endian Control register. This enables byte swapping when used with 16-bit hosts.

### 9.8.3 Busy Signal

The Busy signal (BUSY#) indicates that DiskOnChip G4 has not yet completed internal initialization. After reset, BUSY# is asserted while the IPL is downloaded into the internal boot block and the Data Protection Structures (DPS) are downloaded to the Protection State Machines. Once the download process is completed, BUSY# is negated. It can be used to delay the first access to DiskOnChip G4 until it is ready to accept valid cycles.

Note: DiskOnChip G4 does NOT use this signal to indicate that the flash is in busy state (e.g. program, read, or erase).

### 9.8.4 Working with 8/16/32-Bit Systems

DiskOnChip G4 uses a 16-bit data bus and supports 16-bit data access by default. However, it can be configured to support 8 or 32-bit data access mode. This section describes the connections required for each mode.

The default of the TrueFFS driver for DiskOnChip G4 is set to work in 16-bit mode. It must be specially configured to support 8 and 32-bit mode. Please see TrueFFS documentation for further details.

Note: The DiskOnChip data bus must be connected to the Least Significant Bits (LSB) of the system. The system engineer must verify whether the matching host signals are SD[7:0], SD[15:8] or D[31:24].

### 8-Bit (Byte) Data Access Mode

When configured for 8-bit operation, pin/ball IF\_CFG should be connected to VSS, and data lines D[15:8] are internally pulled up and may be left unconnected. The controller routes odd and even address accesses to the appropriate byte lane of the flash and RAM.

Host address SA0 must be connected to DiskOnChip G4 A0, SA1 must be connected to A1, etc.

### 16-Bit (Word) Data Access Mode

To set DiskOnChip G4 to work in 16-bit mode, the IF\_CFG pin/ball must be connected to VCC.

In 16-bit mode, the Programmable Boot Block is accessed as a true 16-bit device. It responds with the appropriate data when the CPU issues either an 8-bit or 16-bit read cycle. The flash area is accessed as a 16/32-bit device, regardless of the interface bus width. This has no affect on the design of the interface between DiskOnChip G4 and the host. The TrueFFS driver handles all issues regarding moving data in and out of DiskOnChip G4.

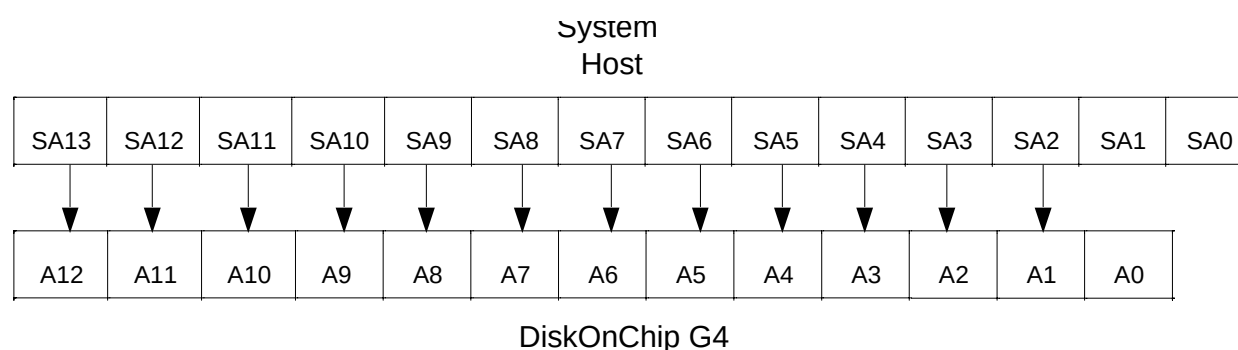
See Table 4 for A0 and IF\_CFG settings for various functionalities with 8/16-bit data access.

Table 4: Active Data Bus Lines in 8/16-Bit Configuration

| A0 | IF_CFG | Functionality                                    |
|----|--------|--------------------------------------------------|
| 0  | 1      | 16-bit access through both buses                 |
| 0  | 0      | 8-bit access to even bytes through low 8-bit bus |
| 1  | 0      | 8-bit access to odd bytes through low 8-bit bus  |
| 1  | 1      | Illegal                                          |

### 32-Bit (Double Word) Data Access Mode

In a 32-bit bus system that cannot execute byte- or word-aligned accesses, the system address lines SA0 and SA1 are always 0. Consecutive double words (32-bit words) are differentiated by SA2 toggling. Therefore, in 32-bit systems that support only 32-bit data access cycles, DiskOnChip G4 signal A0 is connected to VSS and A1 is connected to the first system address bit that toggles; i.e., SA2.



Note: The prefix "S" indicates system host address lines

Figure 17: Address Shift Configuration for 32-Bit Data Access Mode

## 9.9 Design Environment

DiskOnChip G4 provides a complete design environment consisting of:

- Evaluation boards (EVBs) for enabling software integration and development with DiskOnChip G4, even before the target platform is available.
- Programming solutions:
  - ☐ Programmer
  - ☐ Programming house
  - ☐ On-board programming
- TrueFFS Software Development Kit (SDK) and Boot Software Development Kit (BDK)
- DOS/XP utilities:
  - ☐ DFORMAT
  - ☐ DIMAGE
  - ☐ DINFO
- Documentation:
  - ☐ Data sheet
  - ☐ Application notes
  - ☐ Technical notes
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## 10. PRODUCT SPECIFICATIONS

### 10.1 Environmental Specifications

#### 10.1.1 Operating Temperature

Commercial temperature range: 0°C to +70°C

Extended temperature range: -40°C to +85°C

#### 10.1.2 Thermal Characteristics

Table 5: Thermal Characteristics

| Thermal Resistance (°C/W)              |                                           |
|----------------------------------------|-------------------------------------------|
| Junction to Case ( $\theta_{JC}$ ): 30 | Junction to Ambient ( $\theta_{JA}$ ): 85 |

#### 10.1.3 Humidity

10% to 90% relative, non-condensing

### 10.2 Electrical Specifications

#### 10.2.1 Absolute Maximum Ratings

Table 6: Absolute Maximum Ratings

| Symbol                       | Parameter                                                          | Rating <sup>1</sup>         | Unit |
|------------------------------|--------------------------------------------------------------------|-----------------------------|------|
| VCC                          | DC core supply voltage                                             | -0.6 to 4.6                 | V    |
| VCCQ                         | DC I/O supply voltage                                              | -0.6 to 4.6                 | V    |
| T <sub>1SUPPLY</sub>         | Maximum duration of applying VCCQ without VCC, or VCC without VCCQ | 1000                        | msec |
| I <sub>IN</sub>              | Input pin/ball current (25 °C)                                     | -10 to 10                   | mA   |
| V <sub>IN</sub> <sup>2</sup> | Input pin/ball voltage                                             | -0.6 to VCCQ+0.3V, 4.6V max | V    |
| T <sub>STG</sub>             | Storage temperature                                                | -55 to 150                  | °C   |
| ESD: Charged Device Model    | ESD <sub>CDM</sub>                                                 | 1000                        | V    |
| ESD: Human Body Model        | ESD <sub>HBM</sub>                                                 | 2000                        | V    |
| Lead temperature             | Tlead (10 sec)                                                     | 260                         | °C   |

1. Permanent device damage may occur if absolute maximum ratings are exceeded. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
2. The voltage on any ball may undershoot to -2.0 V or overshoot to 6.6V for less than 20 ns.
3. When operating DiskOnChip G4 with separate power supplies for VCC and VCCQ, it is recommended to turn both supplies on and off simultaneously. Providing power separately (either at power-on or power-off) can cause excessive power dissipation. Damage to the device may result if this condition persists for more than 1 second.

#### 10.2.2 Capacitance

Table 7: Capacitance

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------|-----------|------------|-----|-----|-----|------|
|--------|-----------|------------|-----|-----|-----|------|

|           |                                       |               |  |  |    |    |
|-----------|---------------------------------------|---------------|--|--|----|----|
| $C_{IN}$  | Input capacitance (128MB/1Gb device)  | $V_{IN} = 0V$ |  |  | 10 | pF |
|           | Input capacitance (256MB/2Gb device)  |               |  |  | 20 | pF |
| $C_{OUT}$ | Output capacitance (128MB/1Gb device) | $V_O = 0V$    |  |  | 10 | pF |
|           | Output capacitance (256MB/2Gb device) |               |  |  | 20 | pF |

Capacitance is not 100% tested.

### 10.2.3 DC Electrical Characteristics over Operating Range

See Table 8 for DC characteristics for VCCQ ranges 1.65-1.95V and 2.5-3.6V I/O,

Table 8: DC Characteristics, VCC = 2.5V-3.6V, VCCQ = 2.5V-3.6V or 1.65V-1.95V

| Symbol      | Parameter                                                  | Conditions                                       | Min               | Typ               | Max      | Unit    |
|-------------|------------------------------------------------------------|--------------------------------------------------|-------------------|-------------------|----------|---------|
| VCC         | Core supply voltage                                        |                                                  | 2.5               | 3.3               | 3.6      | V       |
| VCCQ        | Input/Output supply voltage                                |                                                  | 2.5               | 3.3               | 3.6      | V       |
| $V_{IH}$    | High-level input voltage                                   | $VCCQ < 2.7V$                                    | 2.0               |                   |          | V       |
|             |                                                            | $VCCQ \geq 2.7V$                                 | $VCCQ \cdot 0.75$ |                   |          | V       |
| $V_{IL}$    | Low-level input voltage                                    | $VCCQ < 2.5V$                                    |                   |                   | 0.6      | V       |
|             |                                                            | $VCCQ \geq 2.5V$                                 |                   |                   | 0.7      | V       |
| $I_{OHmax}$ | Maximum high level output current                          | $3.0V < VCCQ < 3.6V$                             | -4                |                   |          | mA      |
|             |                                                            | $2.5V < VCCQ < 3.0V$                             | -4                |                   |          | mA      |
| $I_{OLmax}$ | Maximum low-level output current                           | $3.0V < VCCQ < 3.6V$                             | 8                 |                   |          | mA      |
|             |                                                            | $2.5V < VCCQ < 3.0V$                             | 5                 |                   |          | mA      |
| $I_{ILK}$   | Input leakage current <sup>2,4</sup><br>(128MB/1Gb device) |                                                  |                   |                   | $\pm 10$ | $\mu A$ |
|             | Input leakage current <sup>2,4</sup><br>(256MB/2Gb device) |                                                  |                   |                   | $\pm 20$ | $\mu A$ |
| $I_{IOLK}$  | Output leakage current<br>(128MB/1Gb device)               |                                                  |                   |                   | $\pm 10$ | $\mu A$ |
|             | Output leakage current<br>(256MB/2Gb device)               |                                                  |                   |                   | $\pm 20$ | $\mu A$ |
| $V_{OH}$    | Low-level output voltage                                   | $I_{OH} = -4 \text{ mA}$<br>$2.5V < VCCQ < 2.7V$ | $VCCQ - 0.3$      |                   |          | V       |
|             |                                                            | $I_{OH} = -4 \text{ mA}$<br>$2.7V < VCCQ < 3.6V$ | 2.4               |                   |          |         |
| $V_{OL}$    | Low-level output voltage                                   | $I_{OL} = 5 \text{ mA}$<br>$2.5V < VCCQ < 3.0V$  |                   |                   | 0.4      | V       |
|             |                                                            | $I_{OL} = 8 \text{ mA}$<br>$3.0V < VCCQ < 3.6V$  |                   |                   | 0.4      | V       |
| $I_{CC}$    | Active supply current <sup>1</sup><br>VCC, VCCq balls      | Read<br>Program<br>Erase<br>Cycle Time = 100 ns  |                   | 4.2<br>7.4<br>7.4 | 45       | mA      |



| Symbol            | Parameter                                                | Conditions                                                                                   | Min | Typ | Max  | Unit |
|-------------------|----------------------------------------------------------|----------------------------------------------------------------------------------------------|-----|-----|------|------|
| I <sub>CCS</sub>  | Standby supply current,<br>(128MB/1Gb single-die device) | RSTIN# = VSS or<br>DPD Mode <sup>3</sup> ,<br>CE# = VCCQ,<br>All other inputs VSS or<br>VCCQ |     | 10  | 40   | μA   |
|                   |                                                          | Normal mode, CE# =<br>VCCQ, All other inputs<br>0V or VCCQ                                   |     | 350 | 600  | μA   |
|                   | Standby supply current,<br>(256MB/2Gb dual-die device)   | RSTIN# = VSS or<br>DPD Mode <sup>3</sup> ,<br>CE# = VCCQ,<br>All other inputs VSS or<br>VCCQ |     | 20  | 80   | μA   |
|                   |                                                          | Normal mode, CE# =<br>VCCQ, All other inputs<br>0V or VCCQ                                   |     | 700 | 1200 | μA   |
| I <sub>CCqs</sub> | Standby supply current<br>VCCQ                           | All inputs 0x or VCCQ                                                                        |     | 1.0 | 6    | μA   |

1. VCC = VCCQ = 3.0V, Outputs open
2. The CE# input includes a pull-up resistor which sources 0.3~3.0 μA at Vin=0V
3. Deep Power-Down mode is achieved by asserting RSTIN# (when in Normal mode) or writing the proper write sequence to the DiskOnChip registers, and asserting the CE# input = VCCQ.
4. SCL and SDA include bus-holders with a feedback resistor of 250K Ohms +/- 40%.

## 10.2.4 AC Operating Conditions

Timing specifications are based on the conditions defined below.

*Table 9: AC Characteristics*

| Parameter                        | VCCQ = 1.65-1.95V                 | VCCQ = 2.5-3.6V<br>OR<br>1.65-1.95V |
|----------------------------------|-----------------------------------|-------------------------------------|
| Ambient temperature (TA)         | -40°C to +85°C                    | -40°C to +85°C                      |
| Core supply voltage (VCC)        | 1.65V-1.95V                       | 2.5V to 3.6V                        |
| Input pulse levels               | 0.2/VCCQ-0.2V                     | 0V/2.5V                             |
| Input rise and fall times        | 3 ns                              | 3 ns                                |
| Input timing levels              | 0.9V                              | 1.5V                                |
| Output timing levels             | 0.9V                              | 1.5V                                |
| Output Load, D[15:0]             | 30 pF                             | 100 pF                              |
| Output Load, IRQ#, DMARQ#, BUSY# | 560 Ohms to VCCQ,<br>10 pF to GND | 560 Ohms to VCCQ,<br>10 pF to GND   |

## 10.3 Timing Specifications

### 10.3.1 Read Cycle Timing Standard Interface

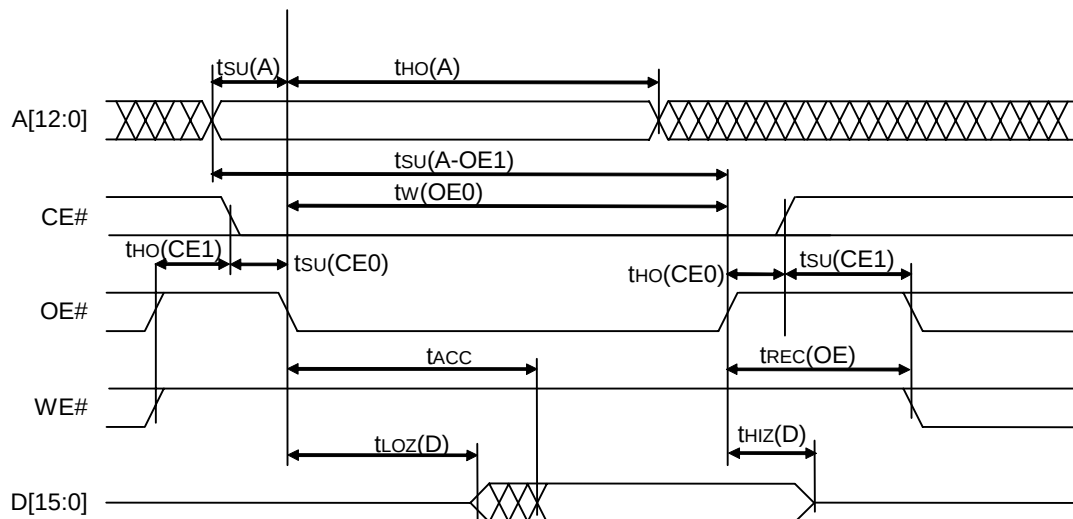


Figure 18: Standard Interface, Read Cycle Timing

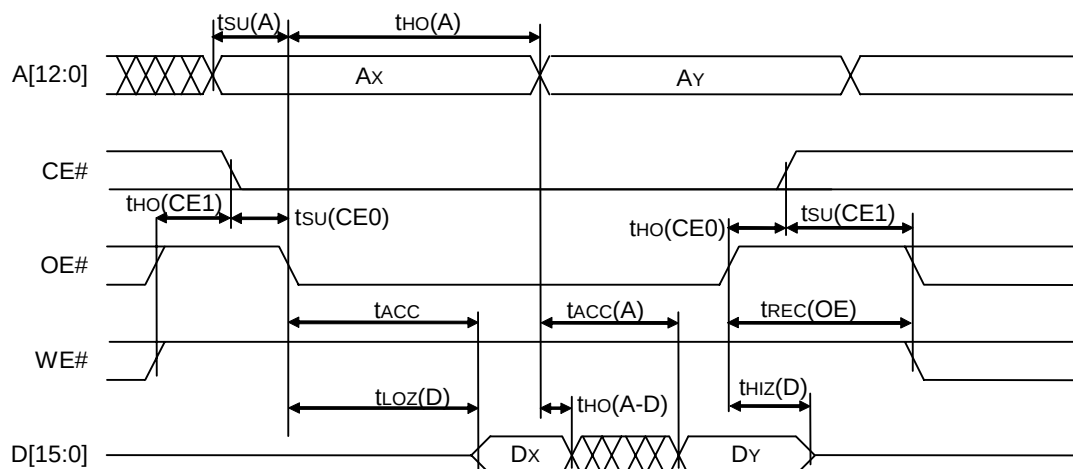


Figure 19: Standard Interface Read Cycle Timing – Asynchronous Boot Mode

Error! Objects cannot be created from editing field codes.

Figure 20: SRAM Paged Mode Register Read Cycle Timing (3 cycles shown)

Table 10: Standard Interface Read Cycle Timing Parameters

| Symbol                                           | Description                                                      | VCCQ=VCC=2.5-3.6V<br>OR<br>VCCQ= 1.65-1.95V<br>VCC=2.5-3.6V |     | Units |
|--------------------------------------------------|------------------------------------------------------------------|-------------------------------------------------------------|-----|-------|
|                                                  |                                                                  | Min                                                         | Max |       |
| Tsu(A)                                           | Address to OE# ↓ setup time <sup>1</sup>                         | -8                                                          |     | ns    |
| Tsu(A-OE1)                                       | Address to OE# ↑ setup time <sup>2</sup>                         | 26                                                          |     | ns    |
| Tw(OE0)                                          | OE# low pulse width <sup>1,2</sup>                               | 38                                                          |     | ns    |
| Tho(A)                                           | OE# ↓ to Address hold time <sup>5</sup>                          | 30                                                          |     | ns    |
| Tsu(CE0)                                         | CE# ↓ to OE# ↓ setup time <sup>1</sup>                           | —                                                           |     | ns    |
| Tho(CE0)                                         | OE# ↑ to CE# ↑ hold time <sup>3</sup>                            | —                                                           |     | ns    |
| Tho(CE1)                                         | OE# or WE# ↑ to CE# ↓ hold time <sup>2</sup>                     | 5                                                           |     | ns    |
| Tsu(CE1)                                         | CE# ↑ to WE# ↓ or OE# ↓ setup time                               | 5                                                           |     | ns    |
| Trec(OE)                                         | OE# negated to start of next cycle <sup>2</sup>                  | 20                                                          |     | ns    |
| Tacc                                             | Read access time (RAM) <sup>1,4</sup>                            |                                                             | 82  | ns    |
|                                                  | Read access time (all other addresses) <sup>1</sup>              |                                                             | 46  |       |
| Tloz(D)                                          | OE# ↓ to D driven <sup>3</sup>                                   | 3                                                           |     | ns    |
| Thiz(D)                                          | OE# ↑ to D Hi-Z delay <sup>3,7</sup>                             |                                                             | 21  | ns    |
| <b>Asynchronous RAM Read Cycle Parameters</b>    |                                                                  |                                                             |     |       |
| Tacc(A)                                          | RAM Read access time from A[9:1]                                 |                                                             | 76  | ns    |
|                                                  | RAM Read access time from A[0] (IF_CFG=0)                        |                                                             | 49  | ns    |
| Tho(A-D)                                         | Data hold time from A[9:0] (RAM)                                 | 0                                                           |     | ns    |
| <b>Paged Mode Register Read Cycle Parameters</b> |                                                                  |                                                             |     |       |
| T1x(A1)                                          | Start of A[1] single transition region before OE# ↓ <sup>6</sup> | 31                                                          |     | ns    |
| Tacc(A1)                                         | Access time from A[1]                                            |                                                             | 64  | ns    |
| Tho(A1-D)                                        | A[1] to D output hold time                                       | 10                                                          |     | ns    |
| Tsu(A1-OE0)                                      | A[1] to OE# ↓ setup time <sup>1</sup>                            | -8                                                          |     | ns    |
| Tho(OE1-A1)                                      | OE# ↑ to A[1] hold time <sup>2</sup>                             | -17                                                         |     | ns    |
| Tho(OE0-A1)                                      | OE# ↓ to A[1] hold time <sup>1,8</sup>                           | 33                                                          |     | ns    |
| Trec(A1)                                         | A[1] to start of next cycle <sup>10</sup>                        | 99                                                          |     | ns    |
| Tcyc(A1)                                         | Time between A[1] transitions <sup>9</sup>                       | 60                                                          |     | ns    |

1. CE# may be asserted any time before or after OE# is asserted. If CE# is asserted after OE#, all timing relative to OE# asserted will be referenced instead to the time of CE# asserted.

2. CE# may be negated any time before or after OE# is negated. If CE# is negated before OE#, all timing relative to OE# negated will be referenced instead to the time of CE# negated.
3. No load (CL = 0 pF).
4. Access time 700 ns on the first read cycle when exiting Power-Down Mode if correct data is required from the RAM..
5. For RAM read cycles, the Address must be held valid until after the data is latched by the host.
6. A[1] may have no more than 1 transition in the region between t1X(A1) and tsu(A), and may have no transitions between tsu(A) and tho(A).
7. Does not include output buffer Hi-Z delay (TBD).
8. tho(OE0-A1) is effectively limited by Tacc + tho(A1-D).
9. Tcyc(A1) is effectively limited by Tacc(A1).
10. trec(A1) is measured from the last A[1] transition which clocks data out to the assertion of (CE# and OE#) or (CE# and WE#)

### 10.3.2 Write Cycle Timing Standard Interface

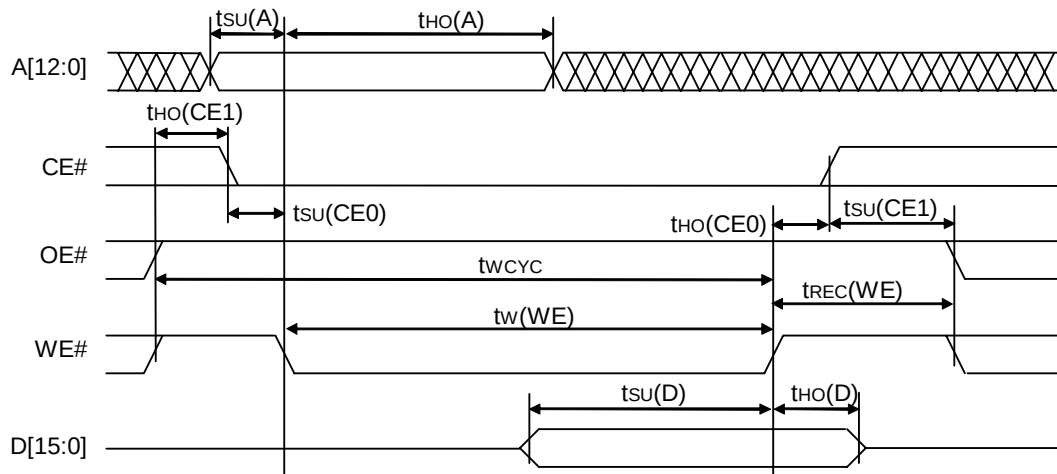


Figure 21: Standard Interface Write Cycle Timing

Table 11: Standard Interface Write Cycle Parameters

| Symbol   | Description                               | VCCQ=VCC=2.5-3.6V<br>OR<br>VCCQ= 1.65-1.95V<br>VCC=2.5-3.6V |     | Units |
|----------|-------------------------------------------|-------------------------------------------------------------|-----|-------|
|          |                                           | Min                                                         | Max |       |
| Tsu(A)   | Address to WE# ↓ setup time               | -4                                                          |     | ns    |
| Tho(A)   | WE# ↓ to Address hold time                | 30                                                          |     | ns    |
| Tw(WE)   | WE# asserted width (RAM)                  | 42                                                          |     | ns    |
|          | WE# asserted width (all other addresses)  | 38                                                          |     | ns    |
| Tsu(CE0) | CE# ↓ to WE# ↓ setup time <sup>1</sup>    | --                                                          |     | ns    |
| Tho(CE0) | WE# ↑ to CE# ↑ hold time <sup>2</sup>     | --                                                          |     | ns    |
| Tho(CE1) | OE# or WE# ↑ to CE# ↓ hold time           | 5                                                           |     | ns    |
| Tsu(CE1) | CE# ↑ to WE# ↓ or OE# ↓ setup time        | 5                                                           |     | ns    |
| Trec(WE) | WE# ↑ to start of next cycle <sup>4</sup> | 28                                                          |     | ns    |
| Tsu(D)   | D to WE# ↑ setup time                     | 34                                                          |     | ns    |
| Tho(D)   | WE# ↑ to D hold time                      | 0                                                           |     | ns    |
| Twcyc    | Write Cycle Time <sup>3</sup>             | N/A                                                         |     |       |

- CE# may be asserted any time before or after WE# is asserted. If CE# is asserted after WE#, all timing relative to WE# asserted should be referenced to the time CE# was asserted.
- CE# may be negated any time before or after WE# is negated. If CE# is negated before WE#, all timing relative to WE# negated will be referenced to the time CE# was negated.
- Write cycle time is limited by the sum of tw(WE) and trec(WE).

4. Applies to the cycle which immediately follows entering Power Down mode and to special Paged RAM cycle which start a download operation: after writing to the Paged RAM selected Register following cycle (generally the first polling cycle) actually starts the download process. This spec applies to the period following that cycle, i.e. the time between the first and second polling cycles.

### 10.3.3 Read Cycle Timing Multiplexed Interface

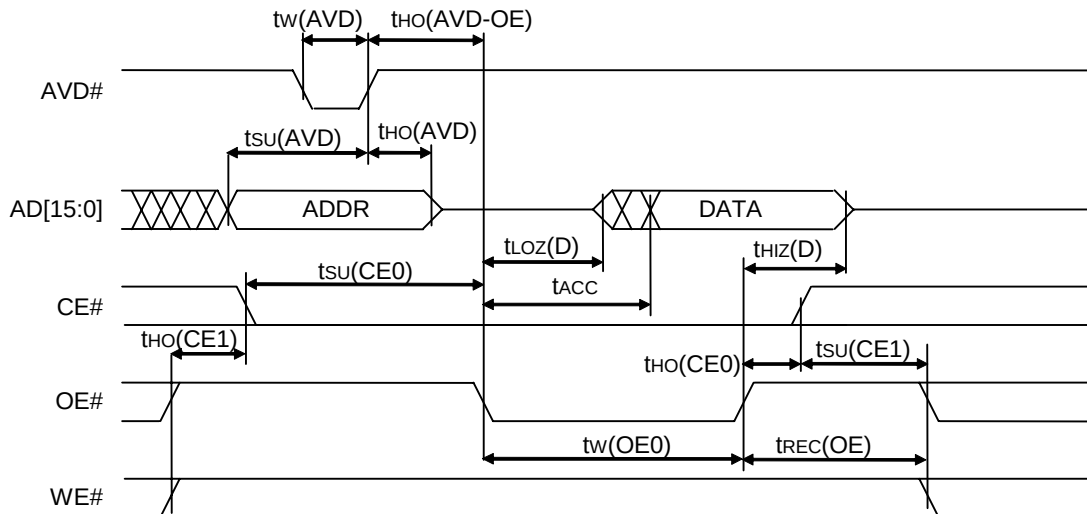


Figure 22: Multiplexed Interface Read Cycle Timing

Table 12: Multiplexed Interface Read Cycle Parameters

| Symbol      | Description                            | VCCQ=VCC=2.5-3.6V<br>OR<br>VCCQ= 1.65-1.95V<br>VCC=2.5-3.6V |     | Units |
|-------------|----------------------------------------|-------------------------------------------------------------|-----|-------|
|             |                                        | Min                                                         | Max |       |
| Tsu(AVD)    | Address to AVD# ↓ setup time           | 8                                                           |     | ns    |
| ThO(AVD)    | AVD# ↑ to address hold time            | 7                                                           |     | ns    |
| Tw(AVD)     | AVD# low pulse width                   | 8                                                           |     | ns    |
| ThO(AVD-OE) | AVD# ↑ to OE# ↓ hold time <sup>1</sup> | 8                                                           |     | ns    |
| Tsu(CE0)    | CE# ↓ to OE# ↓ setup time <sup>1</sup> | —                                                           |     | ns    |
| ThO(CE0)    | OE# ↑ to CE# ↑ hold time <sup>2</sup>  | —                                                           |     | ns    |
| ThO(CE1)    | OE# or WE# ↑ to CE# ↓ hold time        | 5                                                           |     | ns    |
| Tsu(CE1)    | CE# ↑ to WE# ↓ or OE# ↓ setup time     | 5                                                           |     | ns    |
| Trec(OE)    | OE# negated to start of next cycle     | 20                                                          |     | ns    |
| Tacc        | Read access time (RAM)                 |                                                             | 82  | ns    |
|             | Read access time (all other addresses) |                                                             | 38  | ns    |
| Tloz(D)     | OE# ↓ to D driven <sup>3</sup>         | 3                                                           |     | ns    |
| Thiz(D)     | OE# ↑ to D Hi-Z delay <sup>3</sup>     |                                                             | 21  | ns    |
| Tw(OE0)     | OE# low pulse width <sup>1,2</sup>     | 38                                                          |     |       |



| Paged Mode Register Read Cycle Parameters |                                                                  |     |    |    |
|-------------------------------------------|------------------------------------------------------------------|-----|----|----|
| T <sub>1X</sub> (A1)                      | Start of A[1] single transition region before OE# ↓ <sup>4</sup> | 32  |    | ns |
| T <sub>acc</sub> (A1)                     | Access time from A[1]                                            |     | 64 | ns |
| Tho(A1-D)                                 | A[1] to D output hold time <sup>3</sup>                          | 10  |    | ns |
| Tsu(A1-OE0)                               | A[1] to OE# ↓ setup time <sup>1</sup>                            | -8  |    | ns |
| Tho(OE1-A1)                               | OE# ↑ to A[1] hold time <sup>2</sup>                             | -17 |    | ns |
| Tho(OE0-A1)                               | OE# ↓ to A[1] hold time <sup>1</sup>                             | 33  |    | ns |
| Tho(A1-OE1)                               | A[1] to OE# ↑ hold time <sup>2</sup>                             | 60  |    | ns |
| Trec(A1)                                  | A[1] to start of next cycle <sup>5</sup>                         | 99  |    | ns |
| Tcyc(A1)                                  | Time between A[1] transitions                                    | 60  |    | ns |

1. CE# may be asserted any time before or after OE# is asserted. If CE# is asserted after OE#, all timing relative to OE# asserted will be referenced instead to the time of CE# asserted.
2. CE# may be negated any time before or after OE# is negated. If CE# is negated before OE#, all timing relative to OE# negated will be referenced instead to the time of CE# negated.
3. No load (CL = 0 pF).
4. A[1] may have no more than 1 transition in the region between t<sub>1X</sub>(A1) and tsu(A), and may have no transitions between tsu(A) and tho(A).
5. trec(A1) is measured from the last A[1] transition which clocks data out to the assertion of (CE# and OE#) or (CE# and WE#).
6. Please refer to Figure 20 and disregard parameters tho(A) and tsu(A) which are applicable only to the SRAM interface. For the Muxed interface, Tsu(AVD), Tho(AVD), Tw(AVD) and Tho(AVD-OE) apply to Paged mode read cycles as shown in Figure 20
7. Paged Mode is supported only when reading from the Flash Data Register.

### 10.3.4 Write Cycle Timing Multiplexed Interface

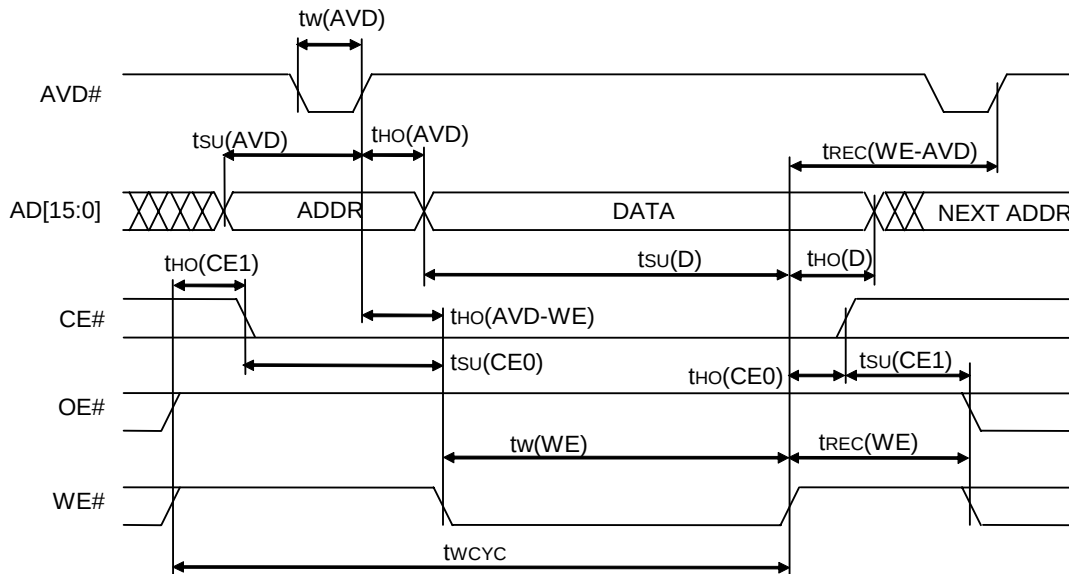


Figure 23: Multiplexed Interface Write Cycle Timing

Table 13: Multiplexed Interface Write Cycle Parameters

| Symbol       | Description                                           | VCCQ=VCC=2.5-3.6V<br>OR<br>VCCQ= 1.65-1.95V<br>VCC=2.5-3.6V |     | Units |
|--------------|-------------------------------------------------------|-------------------------------------------------------------|-----|-------|
|              |                                                       | Min                                                         | Max |       |
| Trec(WE-AVD) | WE# ↑ to AVD# ↑ in next cycle                         | 8                                                           |     | ns    |
| Tsu(AVD)     | Address to AVD# ↓ setup time                          | 8                                                           |     | ns    |
| ThO(AVD)     | Address to AVD# ↑ hold time                           | 7                                                           |     | ns    |
| Tw(AVD)      | AVD# low pulse width                                  | 8                                                           |     | ns    |
| ThO(AVD-WE)  | AVD# ↓↑ to WE# ↓ hold time <sup>1</sup>               | 8                                                           |     | ns    |
| Tw(WE)       | WE# asserted width (RAM) <sup>3</sup>                 | 42                                                          |     | ns    |
|              | WE# asserted width (all other addresses) <sup>3</sup> | 38                                                          |     |       |
| Tsu(CE0)     | CE# ↓ to WE# ↓ setup time <sup>1</sup>                | —                                                           |     | ns    |
| ThO(CE0)     | WE# ↑ to CE# ↑ hold time <sup>2</sup>                 | —                                                           |     | ns    |
| ThO(CE1)     | OE# or WE# ↑ to CE# ↓ hold time                       | 5                                                           |     | ns    |
| Tsu(CE1)     | CE# ↑ to WE# ↓ or OE# ↓ setup time                    | 5                                                           |     | ns    |
| Trec(WE)     | WE# ↑ to start of next cycle                          | 28                                                          |     | ns    |
| Tsu(D)       | D to WE# ↑ setup time                                 | 24                                                          |     | ns    |

|        |                               |     |  |    |
|--------|-------------------------------|-----|--|----|
| Tho(D) | WE# ↑ to D hold time          | 0   |  | ns |
| Twcyc  | Write Cycle Time <sup>4</sup> | N/A |  | ns |

1. CE# may be asserted any time before or after WE# is asserted. If CE# is asserted after WE#, all timing relative to WE# asserted will be referenced instead to the time of CE# asserted.
2. CE# may be negated any time before or after WE# is negated. If CE# is negated before WE#, all timing relative to WE# negated will be referenced instead to the time of CE# negated.
3. WE# may be asserted before or after the rising edge of AVD#. The beginning of the WE# asserted pulse width spec is measured from the later of the falling edge of WE# or the rising edge of AVD#.
4. Write cycle time is limited by the sum of tw(WE) and trec(WE).

### 10.3.5 Read Cycle Timing MultiBurst

In Figure 24, the MultiBurst Control register values are: LATENCY=0, LENGTH=4, CLK\_INV=0.

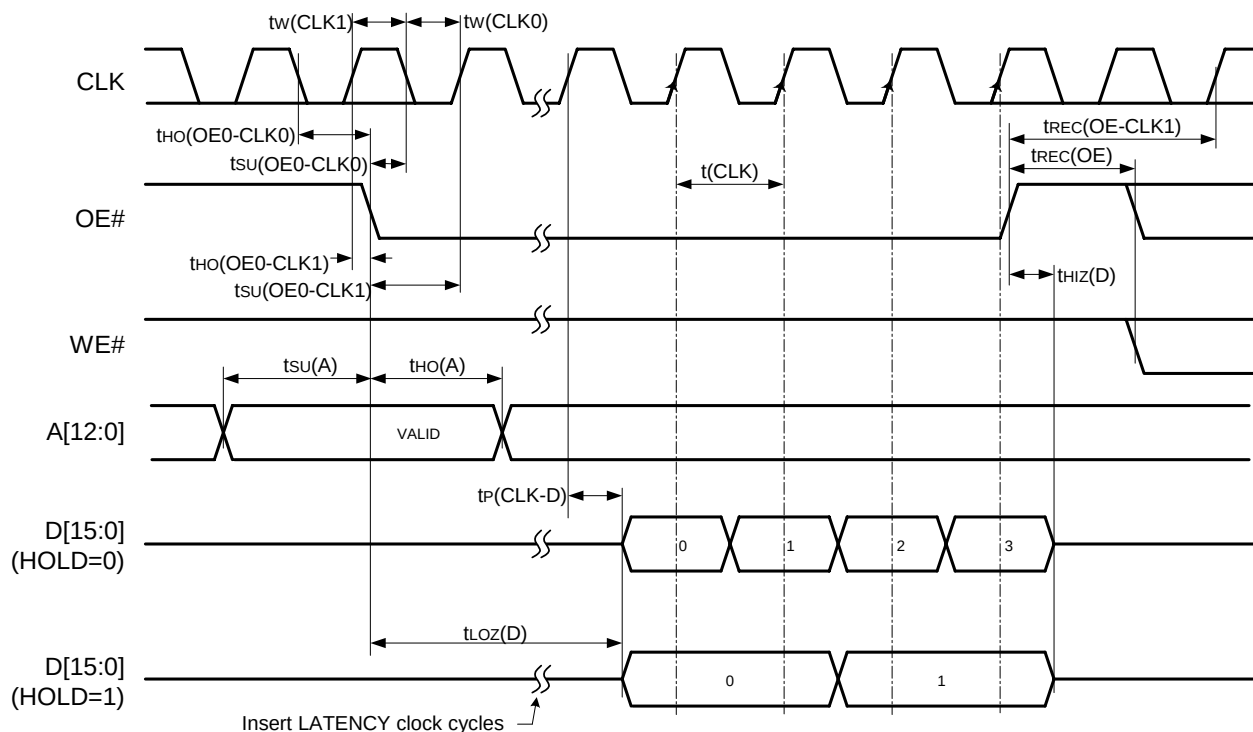


Figure 24: MultiBurst Read Timing

Note: Shown with Burst Mode Controller register values: LATENCY=0, LENGTH=4.

Table 14: MultiBurst Read Cycle Parameters

| Symbol        | Description                                  | VCCQ=VCC=2.5-3.6V<br>OR<br>VCCQ= 1.65-1.95V<br>VCC=2.5-3.6V |     | Units |
|---------------|----------------------------------------------|-------------------------------------------------------------|-----|-------|
|               |                                              | Min                                                         | Max |       |
| Tsu(OE0-CLK1) | OE# ↓ to CLK ↑ setup time <sup>6,7,8</sup>   | 4                                                           |     | ns    |
| Tsu(OE0-CLK0) | OE# ↓ to CLK ↓ setup time <sup>9,10,11</sup> | 3                                                           |     | ns    |
| ThO(OE0-CLK1) | CLK ↑ to OE# ↓ hold time <sup>6,7,8</sup>    | 4                                                           |     | ns    |
| ThO(OE0-CLK0) | CLK ↓ to OE# ↓ hold time <sup>9,10,11</sup>  | 4                                                           |     | ns    |
| Tp(CLK-D)     | CLK ↑ to D delay                             | 3                                                           | 39  | ns    |
| Tw(CLK1)      | CLK high pulse width <sup>6</sup>            | 18                                                          |     | ns    |
|               | CLK high pulse width <sup>7</sup>            | 8                                                           |     | ns    |
|               | CLK high pulse width <sup>8</sup>            | 8                                                           |     | ns    |

| Symbol        | Description                                                                                                                      | VCCQ=VCC=2.5-3.6V<br>OR<br>VCCQ= 1.65-1.95V<br>VCC=2.5-3.6V |     | Units |
|---------------|----------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------|-----|-------|
|               |                                                                                                                                  | Min                                                         | Max |       |
|               | CLK high pulse width <sup>9</sup>                                                                                                | 18                                                          |     | ns    |
|               | CLK high pulse width <sup>10</sup>                                                                                               | 8                                                           |     | ns    |
|               | CLK high pulse width <sup>11</sup>                                                                                               | 8                                                           |     | ns    |
| Tw(CLK0)      | CLK low pulse width <sup>6</sup>                                                                                                 | 17                                                          |     | ns    |
|               | CLK low pulse width <sup>7</sup>                                                                                                 | 8                                                           |     | ns    |
|               | CLK low pulse width <sup>8</sup>                                                                                                 | 8                                                           |     | ns    |
|               | CLK low pulse width <sup>9</sup>                                                                                                 | 17                                                          |     | ns    |
|               | CLK low pulse width <sup>10</sup>                                                                                                | 10                                                          |     | ns    |
|               | CLK low pulse width <sup>11</sup>                                                                                                | 10                                                          |     | ns    |
| T(CLK)        | CLK period <sup>6</sup>                                                                                                          | 50                                                          |     | ns    |
|               | CLK period <sup>7</sup>                                                                                                          | 39                                                          |     | ns    |
|               | CLK period <sup>8</sup>                                                                                                          | 39                                                          |     | ns    |
|               | CLK period <sup>9</sup>                                                                                                          | 50                                                          |     | ns    |
|               | CLK period <sup>10</sup>                                                                                                         | 36                                                          |     | ns    |
|               | CLK period <sup>11</sup>                                                                                                         | 39                                                          |     | ns    |
| TREC(OE)      | OE# negated to start of next cycle <sup>2</sup>                                                                                  | 16                                                          |     | ns    |
| TLOZ(D)       | OE# ↓ to D driven <sup>1,3</sup>                                                                                                 |                                                             | 3   | ns    |
| THIZ(D)       | OE# ↑ to D Hi-Z delay <sup>2</sup>                                                                                               |                                                             | 21  | ns    |
| Tsu(A)        | Address to OE# ↓ setup time <sup>1,12</sup>                                                                                      | -8                                                          |     | ns    |
| Tho(A)        | OE# ↓ to Address hold time <sup>1,12</sup>                                                                                       | 30                                                          |     | ns    |
| TREC(OE-CLK1) | OE# ↑ setup to next CLK rising edge which samples OE_low (trec(OE) + tsu(OE0-CLK1)) <sup>4,5</sup>                               | 24                                                          |     | ns    |
|               | OE# ↑ setup to next CLK rising edge after falling edge which samples OE_low (trec(OE) + tsu(OE0-CLK0) + tw(CLK0)) <sup>4,5</sup> | 28                                                          |     | ns    |

- CE# may be asserted any time before or after OE# is asserted. If CE# is asserted after OE#, all timing relative to OE# asserted will be referenced instead to the time of CE# asserted.
- CE# may be negated any time before or after OE# is negated. If CE# is negated before OE#, all timing relative to OE# negated will be referenced instead to the time of CE# negated.
- No load (CL = 0 pF).
- Applicable only if CLK\_INV bit of the Burst Mode Control Register 0.
- Applicable only if CLK\_INV bit of the Burst Mode Control Register is 1.
- Applicable only if HOLD=0, FIFO=0, INV=0 in the Burst Mode Control Register.
- Applicable only if HOLD=0, FIFO=1, INV=0 in the Burst Mode Control Register.
- Applicable only if HOLD=1, FIFO=0, INV=0 in the Burst Mode Control Register.
- Applicable only if HOLD=0, FIFO=0, INV=1 in the Burst Mode Control Register.

10. Applicable only if HOLD=0, FIFO=1, INV=1 in the Burst Mode Control Register.
11. Applicable only if HOLD=1, FIFO=0, INV=1 in the Burst Mode Control Register.
12. Applicable only with the SRAM interface. For the Muxed interface, Tsu(AVD), Tho(AVD), Tw(AVD) and Tho(AVD-OE) apply as shown in Table 12 and Figure 22.

### 10.3.6 Flash Characteristics

*Table 15: Flash Program, Erase, and Read Timing*

| Symbol             | Description            | Rate |      | Unit |
|--------------------|------------------------|------|------|------|
|                    |                        | Typ  | Max  |      |
| T <sub>PROG</sub>  | Page programming time  | 750  | 2000 | uS   |
| T <sub>ERASE</sub> | Block erasing time     | 3    | 10   | mS   |
| T <sub>READ</sub>  | Even page reading time | 50   | TBD  | uS   |
|                    | Odd page reading time  | 25   | TBD  | uS   |

### 10.3.7 Power Supply Sequence

When operating DiskOnChip G4 with separate power supplies powering the VCCQ and VCC rails, it is desirable to turn both supplies on and off simultaneously. Providing power to one supply rail and not the other (either at power-on or power-off) can cause excessive power dissipation. Damage to the device may result if this condition persists for more than 1000 msec.

### 10.3.8 Power-Up Timing

DiskOnChip G4 is reset by assertion of the RSTIN# input. When this signal is negated, DiskOnChip G4 initiates a download procedure from the flash memory into the internal Programmable Boot Block. During this procedure, DiskOnChip G4 does not respond to read or write accesses.

Host systems must therefore observe the requirements described below for first access to DiskOnChip G4. Any of the following methods may be employed to guarantee first-access timing requirements:

- Use a software loop to wait at least  $T_p$  (BUSY1) before accessing the device after the reset signal is negated.
- Poll the state of the BUSY# output.
- Poll the DL\_RUN bit of the Download Status register until it returns 0. The DL\_RUN bit will be 0 when BUSY# is negated.
- Use the BUSY# output to hold the host CPU in wait state before completing the first access which will be a RAM read cycle. The data will be valid when BUSY# is negated.

Hosts that use DiskOnChip G4 to boot the system must employ option 4 above or use another method to guarantee the required timing of the first-time access.

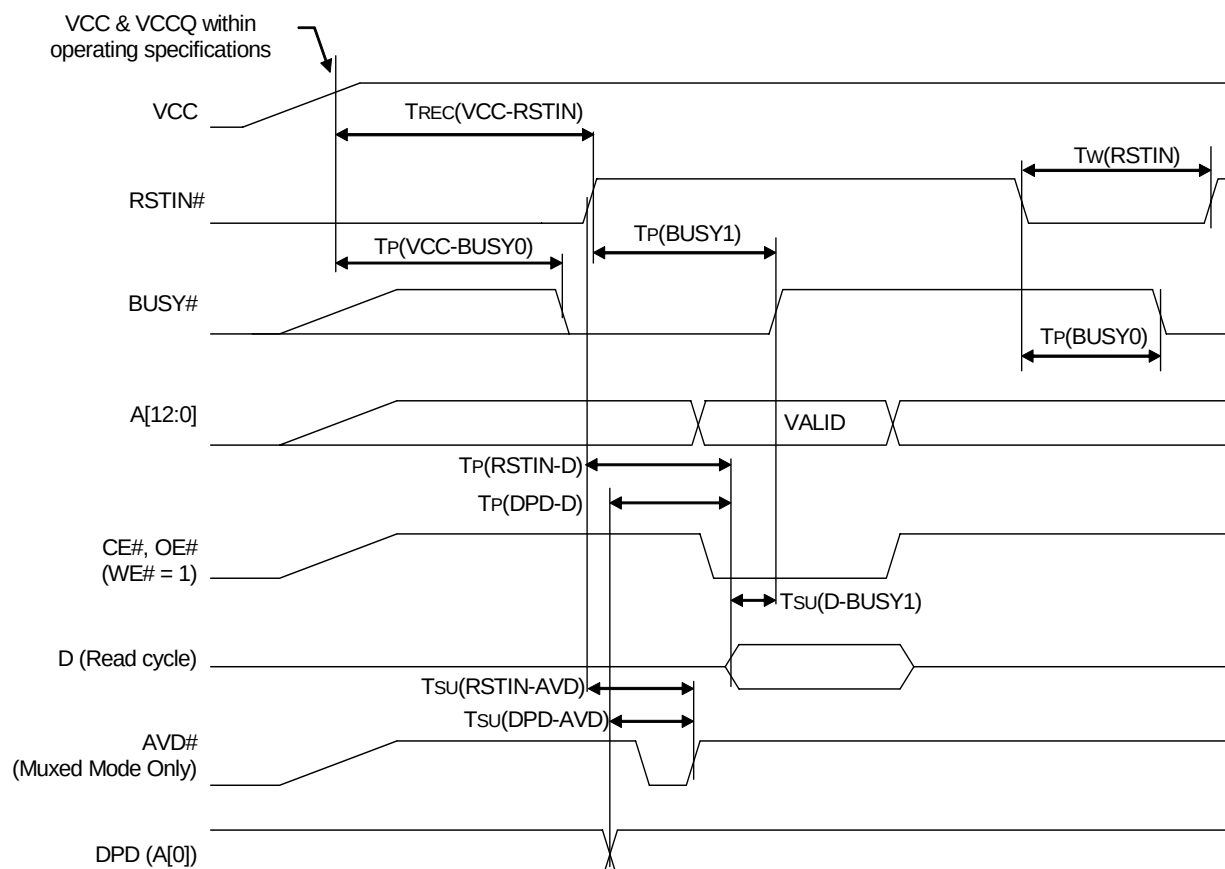


Figure 25: Reset Timing

Table 16: Power-Up Timing Parameters

| Symbol                       | Description                                 | Min | Max | Units |
|------------------------------|---------------------------------------------|-----|-----|-------|
| TREC (VCC-RSTIN)             | VCC/VCCQ stable to RSTIN# ↑ <sup>1</sup>    | 500 |     | μs    |
| Tw (RSTIN)                   | RSTIN# asserted pulse width                 | 50  |     | ns    |
| TP (BUSY0)                   | RSTIN# ↓ to BUSY# ↓                         |     | 50  | ns    |
| TP (BUSY1)                   | RSTIN# ↑ to BUSY# ↑ <sup>3</sup>            |     | 10  | ms    |
| Tsu (D-BUSY1)                | Data valid to BUSY# ↑ <sup>2</sup>          | 0   |     | ns    |
| TP (VCC-BUSY0)               | VCC/VCCQ stable to BUSY# ↓                  |     | 500 | μs    |
| Tsu (RSTIN-AVD) <sup>4</sup> | RSTIN# ↑ to AVD# ↑ <sup>4</sup>             | 4.2 |     | μs    |
| Tsu (DPD-AVD) <sup>4,6</sup> | DPD transition to AVD# ↑ <sup>4,6</sup>     | 600 |     | ns    |
| TP (RSTIN-D) <sup>5</sup>    | RSTIN# ↑ to Data valid                      | 4.4 | 6.1 | μs    |
| TP (DPD-D) <sup>5,6</sup>    | DPD transition to Data valid <sup>5,6</sup> | 700 |     | ns    |
| Trise (RSTIN) <sup>7</sup>   | RSTIN# rise time <sup>7</sup>               |     | 20  | ns    |

1. Specified from the final positive crossing of VCCQ above 1.65 or 2.5V.

2. Normal read/write cycle timing applies. This parameter applies only when the cycle is extended until the negation of the BUSY# signal.

3. If the assertion of RSTIN# occurs during a flash erase cycle, this time could be extended by up to 500 μs.



4. Applies to multiplexed interface only.
5. Applies to SRAM mode only.
6. DPD transition refers to exiting Deep Power Down mode by toggling DPD (A[0]).
7. When DiskOnChip G4 operates with  $VCCQ < 2.5$ , the inputs, including RSTIN#, do not have hysteresis. It is therefore not recommended to drive RSTIN# with a slow rising signal such as an RC network. If such a connection is used, it should be buffered with an external Schmidt-trigger buffer. This requirement may be ignored when operating with  $VCCQ > 2.5V$ .

### 10.3.9 Interrupt Timing

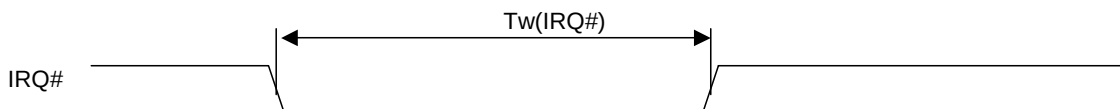
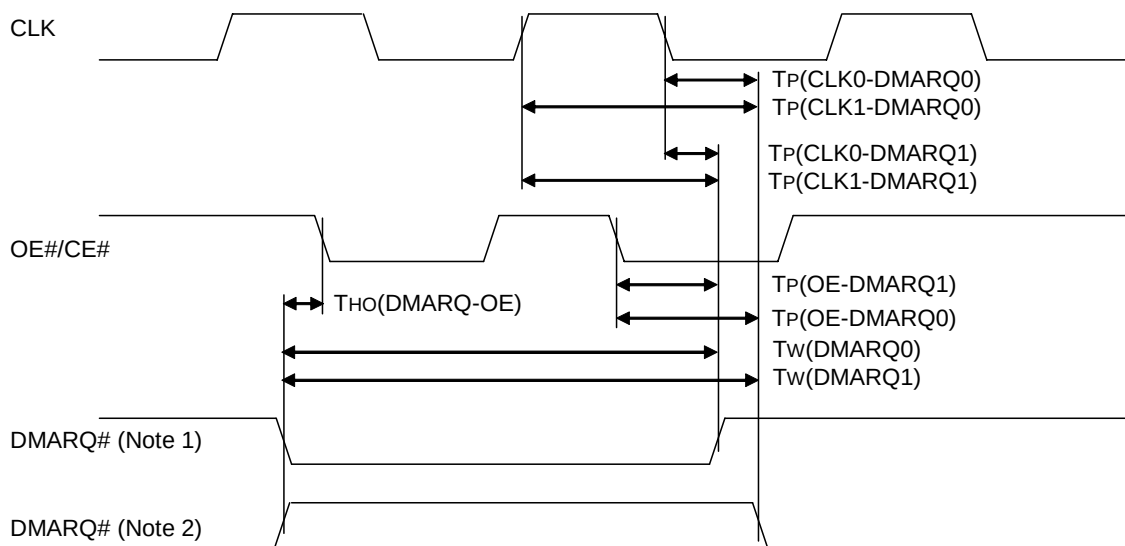


Figure 26: IRQ# Pulse Width in Edge Mode

Table 17: Interrupt Timing

| Symbol   | Description                           | Min | Max | Unit |
|----------|---------------------------------------|-----|-----|------|
| Tw(IRQ#) | IRQ# asserted pulse width (Edge mode) | 330 | 501 | ns   |

### 10.3.10 DMA Request Timing



Notes:

1. NORMAL0 bit of DMA Control Register[0] = 0.
2. NORMAL0 bit of DMA Control Register[0] = 1.

Figure 27: DMARQ# Pulse Width

Table 18: DMA Request Timing

| Symbol                    | Description                      | Min | Max | Unit |
|---------------------------|----------------------------------|-----|-----|------|
| Tw(DMARQ0) <sup>1.6</sup> | DMARQ# asserted low pulse width  | 330 | 501 | nS   |
| Tw(DMARQ1) <sup>1.7</sup> | DMARQ# asserted high pulse width | 330 | 501 | nS   |

|                                  |                                   |   |    |    |
|----------------------------------|-----------------------------------|---|----|----|
| Tho(DMARQ-OE) <sup>8</sup>       | DMARQ# asserted to start of cycle | 0 |    | nS |
| Tp(OE-DMARQ1) <sup>2,3,6</sup>   | OE ↓ to DMARQ# ↑                  |   | 53 | nS |
| Tp(OE-DMARQ0) <sup>2,3,7</sup>   | OE ↓ to DMARQ# ↓                  |   | 53 | nS |
| Tp(CLK0-DMARQ1) <sup>2,4,6</sup> | CLK ↓ to DMARQ# ↑                 |   | 64 | nS |
| Tp(CLK0-DMARQ0) <sup>2,4,7</sup> | CLK ↓ to DMARQ# ↓                 |   | 64 | nS |
| Tp(CLK1-DMARQ1) <sup>2,5,6</sup> | CLK ↑ to DMARQ# ↑                 |   | 57 | nS |
| Tp(CLK1-DMARQ0) <sup>2,5,7</sup> | CLK ↑ to DMARQ# ↓                 |   | 57 | nS |

1. Applies to Edge mode only.
2. Applies to Level mode only.
3. Applies to non-burst mode.
4. Applies to normal-burst mode
5. Applies to FIFO-burst and HOLD-burst modes.
6. NORMAL0 bit of DMA Control Register[0] =0
7. NORMAL0 bit of DMA Control Register[0] =1
8. Not tested. Guaranteed by design.

## 10.4 Mechanical Dimensions

FBGA 128MB (1Gb) dimensions:  $9.0 \pm 0.20$  mm x  $12.0 \pm 0.20$  mm x  $1.1 \pm 0.1$  mm

FBGA 256MB (2Gb) dimensions:  $9.0 \pm 0.20$  mm x  $12.0 \pm 0.20$  mm x  $1.3 \pm 0.1$  mm

Ball pitch: 0.8 mm

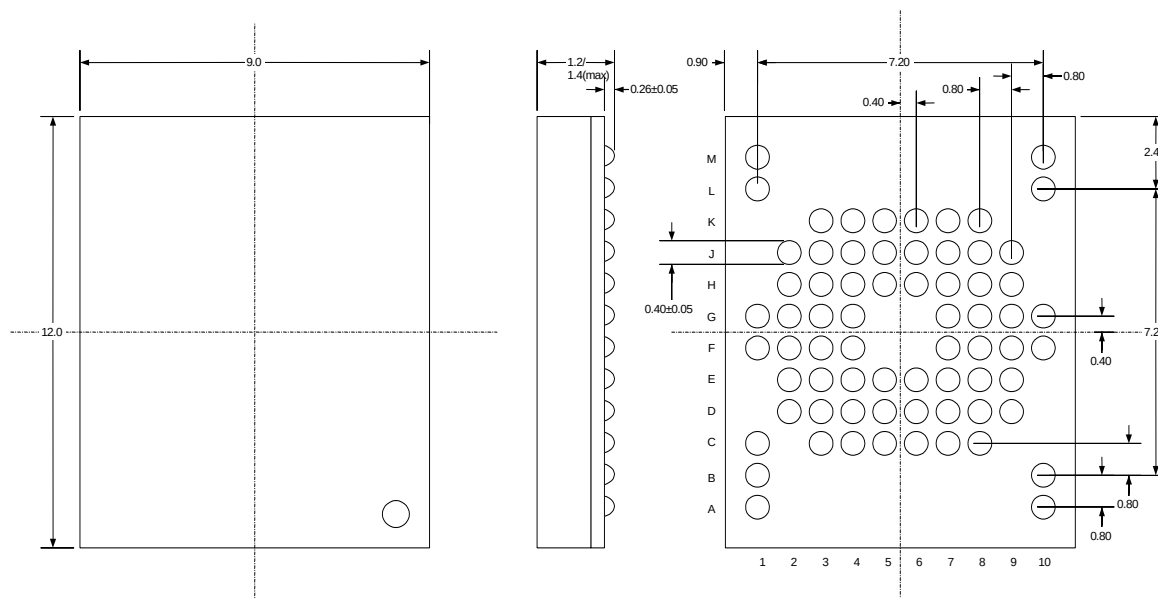


Figure 28: Mechanical Dimensions 9x12 FBGA Package

## 11. ORDERING INFORMATION

Refer to Table 19 for combinations currently available and the associated order numbers.

*Table 19: Available Combinations*

| Ordering Code      | Capacity |              | Core Voltage [V] | Package                              |                    | Temperature Range                                  |
|--------------------|----------|--------------|------------------|--------------------------------------|--------------------|----------------------------------------------------|
|                    | MB       | Mb           |                  |                                      |                    |                                                    |
| MD8832-d1G-V3-X-P  | 128      | 1024 (1Gbit) | 3.3              | BGA 69 balls                         | Pb-free            | Extended                                           |
| MD8331-d2G-V3-X-P  | 256      | 2048 (2Gbit) |                  | BGA 69 balls                         | Pb-free            | Extended                                           |
| MD8832-d00-DAISY-P | 00       | 000          | -                | 69-ball FBGA 9x12 Daisy-Chain        | Pb-free            | Daisy-chain format for package reliability testing |
| MD8832-d1Gb-MECH   | 128      | 1024 (1Gbit) | -                | 69-ball FBGA 9x12 Mechanical Samples | Mechanical Samples |                                                    |

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